Features

- High-performance, Low-power AVR 8/16-bit AVR XMEGA Microcontroller
- Non-volatile Program and Data Memories
  - 16K - 128K Bytes of In-System Self-Programmable Flash
  - 4K Boot Code Section with Independent Lock Bits
  - 1K - 2K Bytes EEPROM
  - 2K - 8K Bytes Internal SRAM
- Peripheral Features
  - Four-channel DMA Controller with support for external requests
  - Eight-channel Event System
  - Five 16-bit Timer/Counters
    - Three Timer/Counters with 4 Output Compare or Input Capture channels
    - Two Timer/Counters with 2 Output Compare or Input Capture channels
    - High-Resolution Extensions on all Timer/Counters
    - Advanced Waveform Extension on one Timer/Counter
  - Five USARTs
    - IrDA Extension on one USART
  - Two Two-Wire Interfaces with dual address match (I^2C and SMBus compatible)
  - Two SPIs (Serial Peripheral Interfaces) peripherals
  - AES and DES Crypto Engine
  - 16-bit Real Time Counter with Separate Oscillator
  - One Twelve-channel, 12-bit, 2 Msps Analog to Digital Converter
  - One Two-channel, 12-bit, 1 Msps Digital to Analog Converter
  - Two Analog Comparators with Window compare function
  - External Interrupts on all General Purpose I/O pins
  - Programmable Watchdog Timer with Separate On-chip Ultra Low Power Oscillator
- Special Microcontroller Features
  - Power-on Reset and Programmable Brown-out Detection
  - Internal and External Clock Options with PLL
  - Programmable Multi-level Interrupt Controller
  - Sleep Modes: Idle, Power-down, Standby, Power-save, Extended Standby
  - Advanced Programming, Test and Debugging Interfaces
    - PDI (Program and Debug Interface) for programming, test and debugging
- I/O and Packages
  - 34 Programmable I/O Lines
  - 44-lead TQFP
  - 44-pad MLF
- Operating Voltage
  - 1.6 – 3.6V
- Speed performance
  - 0 – 12 MHz @ 1.6 – 2.7V
  - 0 – 32 MHz @ 2.7 – 3.6V

Typical Applications

- Industrial control
- Factory automation
- Building control
- Board control
- White Goods
- Climate control
- ZigBee
- Motor control
- Networking
- Optical
- Hand-held battery applications
- Power tools
- HVAC
- Metering
- Medical Applications

8/16-bit AVR® XMEGA A4 Microcontroller

ATxmega128A4
ATxmega64A4
ATxmega32A4
ATxmega16A4

Preliminary

8069D–AVR–08/08

1. Ordering Information

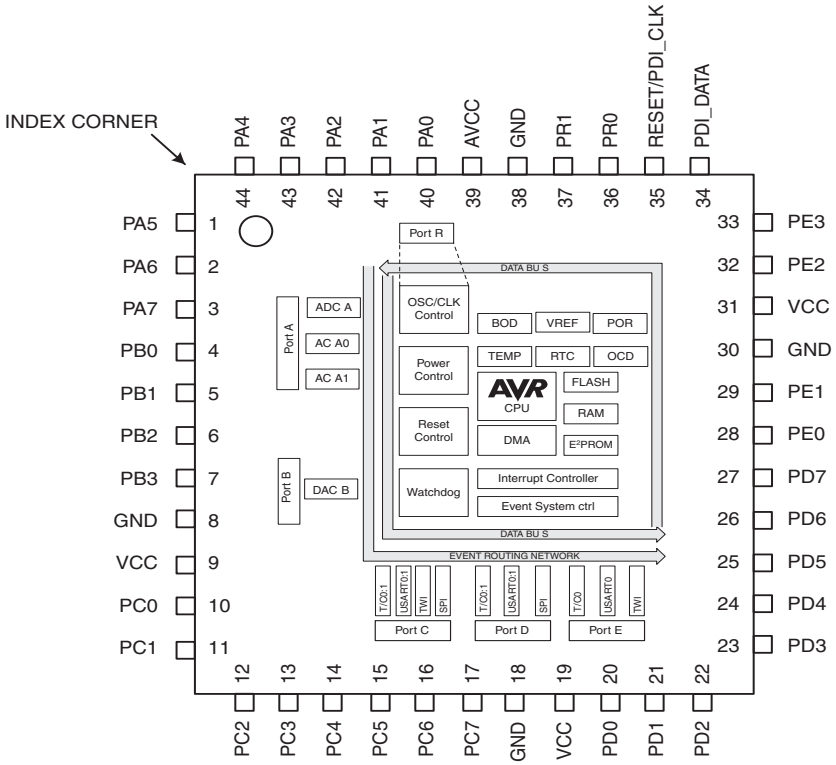
Ordering Code	Flash (B)	E^2 (B)	SRAM (B)	Speed (MHz)	Power Supply	Package[1][2][3]	Temp
ATxmega128A4-AU	128K + 4K	2K	8K	32	1.6 - 3.6V	44A	-40° - 85°
ATxmega64A4-AU	64K + 4K	2K	4K	32	1.6 - 3.6V		
ATxmega32A4-AU	32K + 4K	2K	4K	32	1.6 - 3.6V		
ATxmega16A4-AU	16K + 4K	1K	2K	32	1.6 - 3.6V		
ATxmega128A4-MU	128K + 4K	2K	8K	32	1.6 - 3.6V	44M1	
ATxmega64A4-MU	64K + 4K	2K	4K	32	1.6 - 3.6V		
ATxmega32A4-MU	32K + 4K	2K	4K	32	1.6 - 3.6V		
ATxmega16A4-MU	16K + 4K	1K	2K	32	1.6 - 3.6V		

Notes:
1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information.
2. Pb-free packaging, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
3. For packaging information see ”Packaging information” on page 59.

Package Type	
44A	44-lead, 10 x 10 mm Body Size, 1.0 mm Body Thickness, 0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP)
44M1	44-pad, 7 x 7 x 1.0 mm Body, Lead Pitch 0.50 mm, 5.20 mm Exposed Pad, Micro Lead Frame Package (MLF)

2. Pinout/Block Diagram

Figure 2-1. Bock Diagram and TDFP-pinout.



Note: For full details on pinout and pin functions refer to ”Pinout and Pin Functions” on page 47.

3. Overview

The XMEGA A4 is a family of low power, high performance and peripheral rich CMOS 8/16-bit microcontrollers based on the AVR® enhanced RISC architecture. By executing powerful instructions in a single clock cycle, the XMEGA A4 achieves throughputs approaching 1 Million Instructions Per Second (MIPS) per MHz allowing the system designer to optimize power consumption versus processing speed.

The AVR CPU combines a rich instruction set with 32 general purpose working registers. All the 32 registers are directly connected to the Arithmetic Logic Unit (ALU), allowing two independent registers to be accessed in one single instruction, executed in one clock cycle. The resulting architecture is more code efficient while achieving throughputs many times faster than conventional single-accumulator or CISC based microcontrollers.

The XMEGA A4 devices provides the following features: In-System Programmable Flash with Read-While-Write capabilities, Internal EEPROM and SRAM, four-channel DMA Controller, eight-channel Event System, Programmable Multi-level Interrupt Controller, 34 general purpose I/O lines, 16-bit Real Time Counter (RTC), five flexible 16-bit Timer/Counters with compare modes and PWM, five USARTs, two Two Wire Serial Interfaces (TWIs), two Serial Peripheral Interfaces (SPIs), AES and DES crypto engine, one Twelve-channel, 12-bit ADC with optional differential input with programmable gain, one Two-channel, 12-bit DAC, two analog comparators with window mode, programmable Watchdog Timer with separate Internal Oscillator, accurate internal oscillators with PLL and prescaler and programmable Brown-Out Detection.

The Program and Debug Interface (PDI), a fast 2-pin interface for programming and debugging, is available.

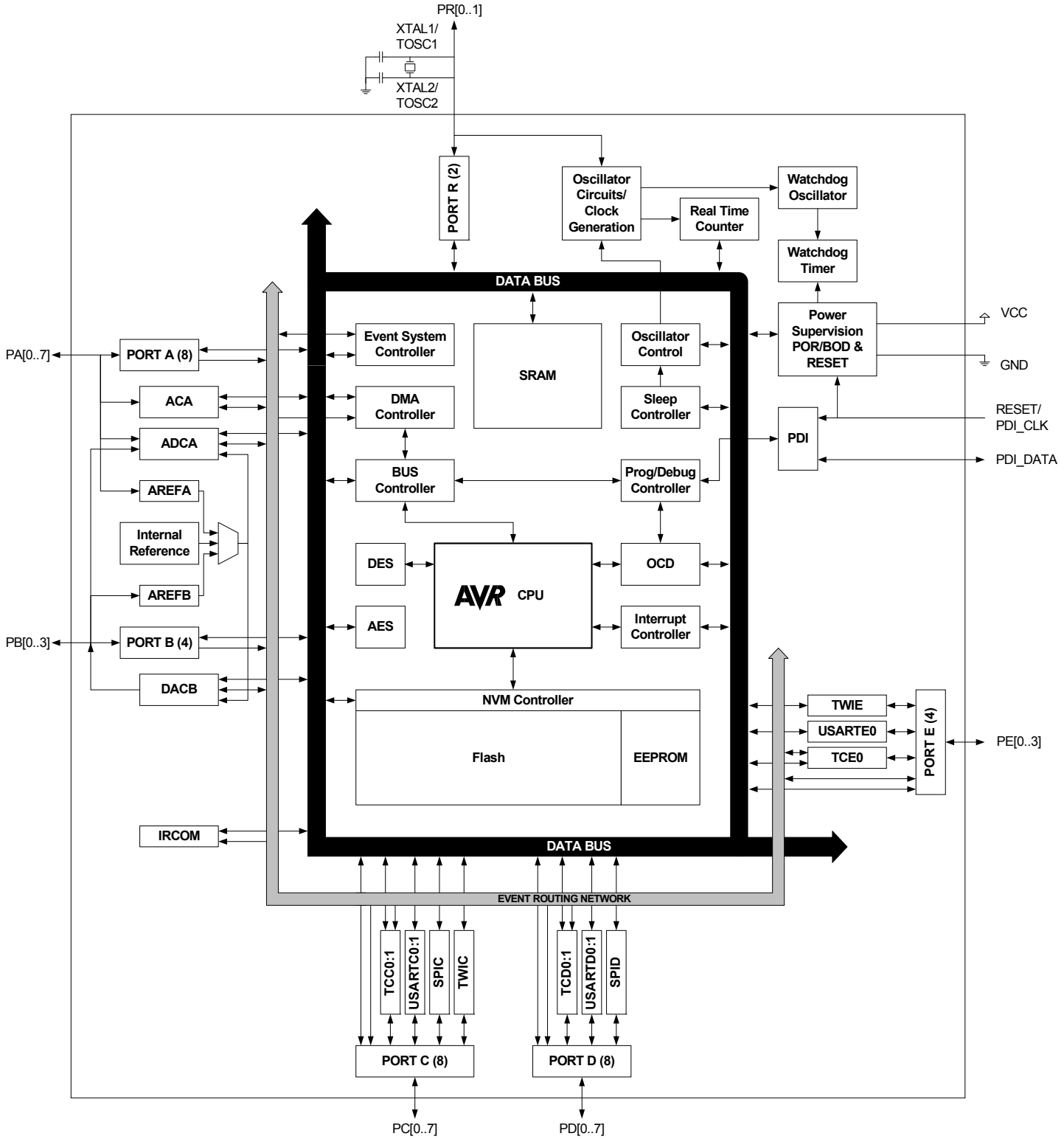
The XMEGA A4 devices have five software selectable power saving modes. The Idle mode stops the CPU while allowing the SRAM, DMA Controller, Event System, Interrupt Controller and all peripherals to continue functioning. The Power-down mode saves the SRAM and register contents but stops the oscillators, disabling all other functions until the next TWI or pin-change interrupt, or Reset. In Power-save mode, the asynchronous Real Time Counter continues to run, allowing the application to maintain a timer base while the rest of the device is sleeping. In Standby mode, the Crystal/Resonator Oscillator is kept running while the rest of the device is sleeping. This allows very fast start-up from external crystal combined with low power consumption. In Extended Standby mode, both the main Oscillator and the Asynchronous Timer continue to run. To further reduce power consumption, the peripheral clock to each individual peripheral can optionally be stopped in Active mode and in Idle sleep mode.

The device is manufactured using Atmel's high-density nonvolatile memory technology. The program Flash memory can be reprogrammed in-system through the PDI. A Bootloader running in the device can use any interface to download the application program to the Flash memory. The Bootloader software in the Boot Flash section will continue to run while the Application Flash section is updated, providing true Read-While-Write operation. By combining an 8/16-bit RISC CPU with In-System Self-Programmable Flash, the Atmel XMEGA A4 is a powerful microcontroller family that provides a highly flexible and cost effective solution for many embedded applications.

The XMEGA A4 devices is supported with a full suite of program and system development tools including: C compilers, macro assemblers, program debugger/simulators, programmers, and evaluation kits.

3.1 Block Diagram

Figure 3-1. XMEGA A4 Block Diagram



4. Resources

A comprehensive set of development tools, application notes and datasheets are available for download on http://www.atmel.com/avr.

4.1 Recommended reading

- XMEGA A Manual
- XMEGA A Application Notes

This device data sheet only contains part specific information and a short description of each peripheral and module. The XMEGA A Manual describes the modules and peripherals in depth. The XMEGA A application notes contain example code and show applied use of the modules and peripherals.

The XMEGA A Manual and Application Notes are available from http://www.atmel.com/avr.

5. Disclaimer

For devices that are not available yet, typical values contained in this datasheet are based on simulations and characterization of other AVR XMEGA microcontrollers manufactured on the same process technology. Min. and Max values will be available after the device is characterized.

6. AVR CPU

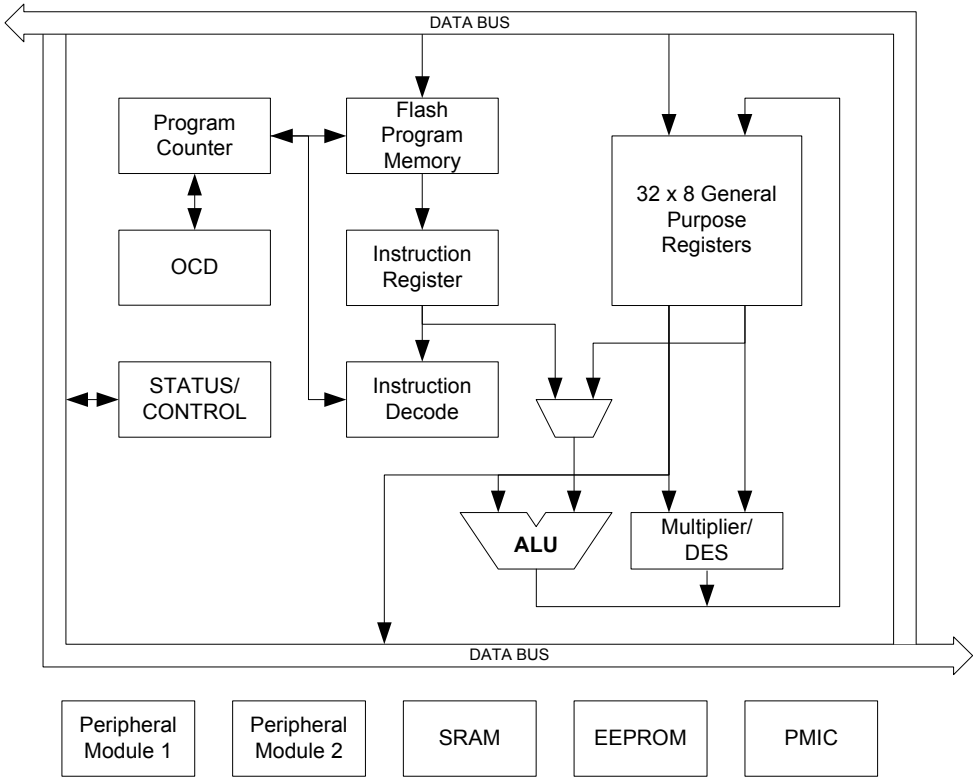
6.1 Features

- 8/16-bit high performance AVR RISC Architecture
  - 138 instructions
  - Hardware multiplier
- 32x8-bit registers directly connected to the ALU
- Stack in RAM
- Stack Pointer accessible in I/O memory space
- Direct addressing of up to 16M Bytes of program and data memory
- True 16/24-bit access to 16/24-bit I/O registers
- Support for 8-, 16- and 32-bit Arithmetic
- Configuration Change Protection of system critical features

6.2 Overview

The XMEGA A4 uses the 8/16-bit AVR CPU. The main function of the CPU is program execution. The CPU must therefore be able to access memories, perform calculations and control peripherals. Interrupt handling is described in a separate section. Figure 6-1 on page 6 shows the CPU block diagram.

Figure 6-1. CPU block diagram



The AVR uses a Harvard architecture - with separate memories and buses for program and data. Instructions in the program memory are executed with a single level pipeline. While one instruction is being executed, the next instruction is pre-fetched from the program memory. This

concept enables instructions to be executed in every clock cycle. The program memory is In-System Re-programmable Flash memory.

6.3 Register File

The fast-access Register File contains 32 x 8-bit general purpose working registers with single clock cycle access time. This allows single-cycle Arithmetic Logic Unit (ALU) operation. In a typical ALU cycle, the operation is performed on two Register File operands, and the result is stored back in the Register File.

Six of the 32 registers can be used as three 16-bit address register pointers for data space addressing - enabling efficient address calculations. One of these address pointers can also be used as an address pointer for look up tables in Flash program memory.

6.4 ALU - Arithmetic Logic Unit

The high performance Arithmetic Logic Unit (ALU) supports arithmetic and logic operations between registers or between a constant and a register. Single register operations can also be executed. Within a single clock cycle, arithmetic operations between general purpose registers or between a register and an immediate are executed. After an arithmetic or logic operation, the Status Register is updated to reflect information about the result of the operation.

The ALU operations are divided into three main categories – arithmetic, logical, and bit-functions. Both 8- and 16-bit arithmetic is supported, and the instruction set allows for efficient implementation of 32-bit arithmetic. The ALU also provides a powerful multiplier supporting both signed and unsigned multiplication and fractional format.

6.5 Program Flow

When the device is powered on, the CPU starts to execute instructions from the lowest address in the Flash Program Memory ‘0’. The Program Counter (PC) addresses the next instruction to be fetched. After a reset, the PC is set to location ‘0’.

Program flow is provided by conditional and unconditional jump and call instructions, capable of addressing the whole address space directly. Most AVR instructions use a 16-bit word format, while a limited number uses a 32-bit format.

During interrupts and subroutine calls, the return address PC is stored on the Stack. The Stack is effectively allocated in the general data SRAM, and consequently the Stack size is only limited by the total SRAM size and the usage of the SRAM. After reset the Stack Pointer (SP) points to the highest address in the internal SRAM. The SP is read/write accessible in the I/O memory space, enabling easy implementation of multiple stacks or stack areas. The data SRAM can easily be accessed through the five different addressing modes supported in the AVR CPU.

7. Memories

7.1 Features

- Flash Program Memory
  - One linear address space
  - In-System Programmable
  - Self-Programming and Bootloader support
  - Application Section for application code
  - Application Table Section for application code or data storage
  - Boot Section for application code or bootloader code
  - Separate lock bits and protection for all sections
- Data Memory
  - One linear address space
  - Single cycle access from CPU
  - SRAM
  - EEPROM
    - Byte or page accessible
    - Optional memory mapping for direct load and store
  - I/O Memory
    - Configuration and Status registers for all peripherals and modules
    - 16-bit accessible General Purpose Register for global variables or flags
  - External Memory support
  - Bus arbitration
    - Safe and deterministic handling of CPU and DMA Controller priority
  - Separate buses for SRAM, EEPROM, I/O Memory and External Memory access
    - Simultaneous bus access for CPU and DMA Controller
- Calibration Row Memory for factory programmed data
  - Oscillator calibration bytes
  - Serial number
  - Device ID for each device type
- User Signature Row
  - One flash page in size
  - Can be read and written from software
  - Data is kept after Chip Erase

7.2 Overview

The AVR architecture has two main memory spaces, the Program Memory and the Data Memory. In addition, the XMEGA A4 features an EEPROM Memory for non-volatile data storage. All three memory spaces are linear and require no paging. The available memory size configurations are shown in ”Ordering Information” on page 2. In addition each device has a Flash memory signature row for calibration data, device identification, serial number etc.

Non-volatile memory spaces can be locked for further write or read/write operations. This prevents unrestricted access to the application software.

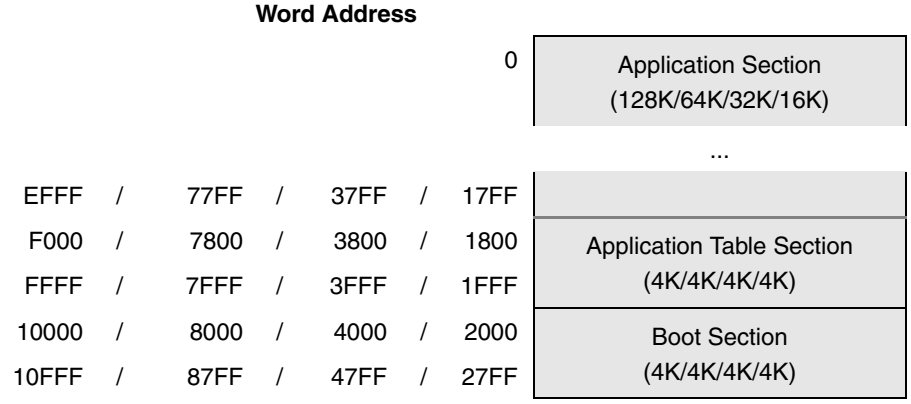
7.3 In-System Programmable Flash Program Memory

The XMEGA A4 devices contains On-chip In-System Programmable Flash memory for program storage, see Figure 7-1 on page 9. Since all AVR instructions are 16- or 32-bits wide, each Flash address location is 16 bits.

The Program Flash memory space is divided into Application and Boot sections. Both sections have dedicated Lock Bits for setting restrictions on write or read/write operations. The Store Program Memory (SPM) instruction must reside in the Boot Section when used to write to the Flash memory.

A third section inside the Application section is referred to as the Application Table section which has separate Lock bits for storage of write or read/write protection. The Application Table section can be used for storing non-volatile data or application software.

Figure 7-1. Flash Program Memory (Hexadecimal address)

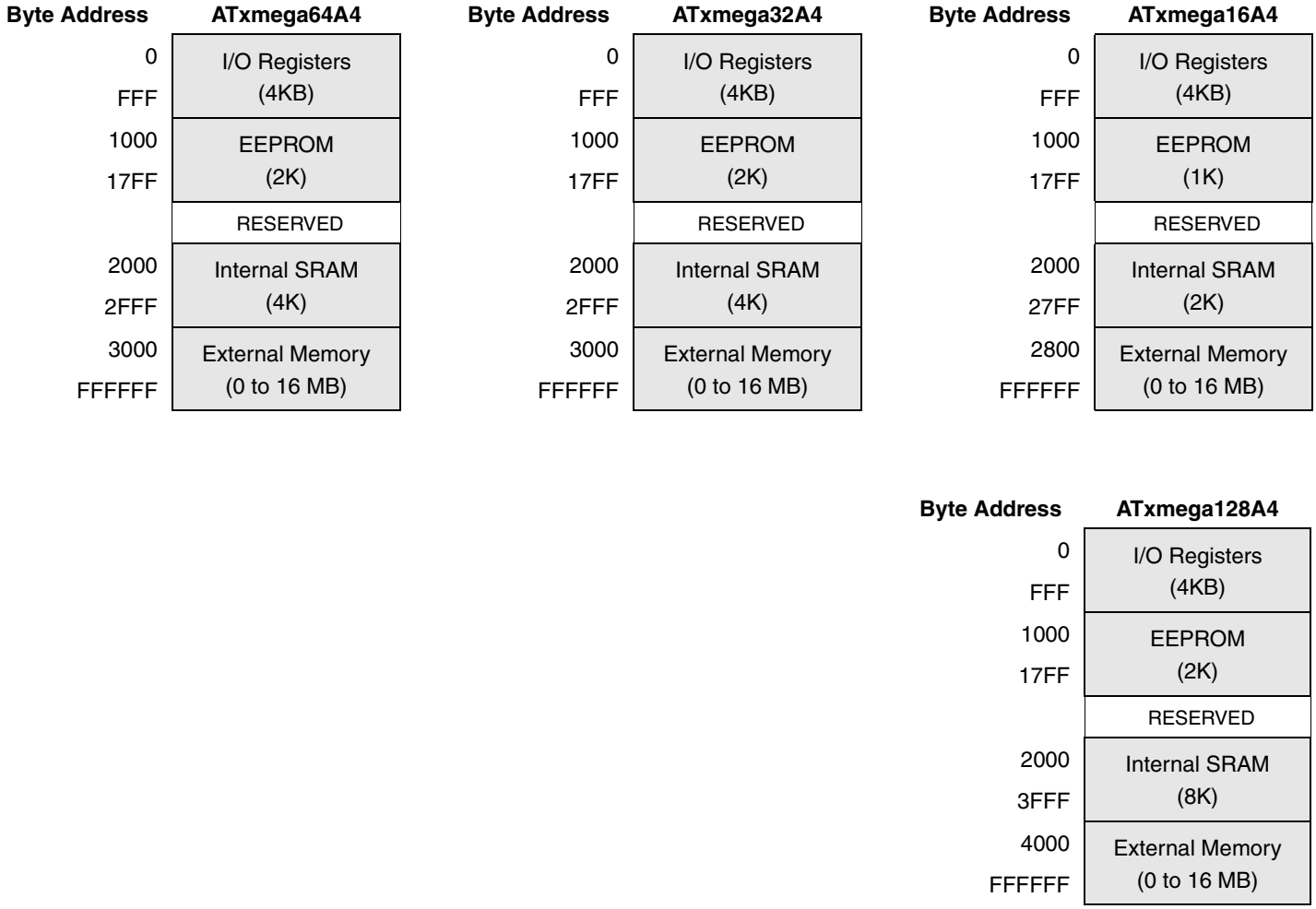


The Application Table Section and Boot Section can also be used for general application software.

7.4 Data Memory

The Data Memory consist of the I/O Memory, EEPROM and SRAM memories, all within one linear address space, see Figure 7-2 on page 10. To simplify development, the memory map for all devices in the family is identical and with empty, reserved memory space for smaller devices.

Figure 7-2. Data Memory Map (Hexadecimal address)



7.4.1 I/O Memory

All peripherals and modules are addressable through I/O memory locations in the data memory space. All I/O memory locations can be accessed by the Load (LD/LDS/LDD) and Store (ST/STS/STD) instructions, transferring data between the 32 general purpose registers in the CPU and the I/O Memory.

The IN and OUT instructions can address I/O memory locations in the range 0x00 - 0x3F directly.

I/O registers within the address range 0x00 - 0x1F are directly bit-accessible using the SBI and CBI instructions. The value of single bits can be checked by using the SBIS and SBIC instructions on these registers.

The I/O memory address for all peripherals and modules in XMEGA A4 is shown in the ”Peripheral Module Address Map” on page 51.

7.4.2 SRAM Data Memory

The XMEGA A4 devices has internal SRAM memory for data storage.

7.4.3 EEPROM Data Memory

The XMEGA A4 devices has internal EEPROM memory for non-volatile data storage. It is addressable either in a separate data space or it can be memory mapped into the normal data memory space. The EEPROM memory supports both byte and page access.

7.5 Calibration Row

The Calibration Row is a separate memory section for factory programmed data. It contains calibration data for functions such as oscillators, device ID, and a factory programmed serial number that is unique for each device. The device ID for the available XMEGA A1 devices is shown in Table 7-1 on page 11. Some of the calibration values will be automatically loaded to the corresponding module or peripheral unit during reset. The Calibration Row can not be written or erased. It can be read from application software and external programming.

Table 7-1. Device ID bytes for XMEGA A4 devices.

Device	Device ID bytes		
	Byte 2	**Byte 1**	**Byte 0**
ATxmega16A4	41	94	1E
ATxmega32A4	41	85	1E
ATxmega64A4	46	96	1E
ATxmega128A4	46	97	1E

7.6 User Signature Row

The User Signature Row is a separate memory section that is fully accessible (read and write) from application software and external programming. The User Signature Row is one flash page in size, and is meant for static user parameter storage, such as calibration data, custom serial numbers, random number seeds etc. This section is not erased by Chip Erase, and requires a dedicated erase command. This ensures parameter storage during multiple program/erase session and On-Chip Debug sessions.

7.7 Flash and EEPROM Page Size

The Flash Program Memory and EEPROM data memory is organized in pages. The pages are word accessible for the Flash and byte accessible for the EEPROM.

Table 7-2 on page 12 shows the Flash Program Memory organization. Flash write and erase operations are performed on one page at the time, while reading the Flash is done one byte at the time. For Flash access the Z-pointer (Z[m:n]) is used for addressing. The most significant bits in the address (FPAGE) gives the page number and the least significant address bits (FWORD) gives the word in the page.

Table 7-2. Number of words and Pages in the Flash.

Devices	Flash	Page Size	FWORD	FPAGE	Application		Boot	
	Size (Bytes)	(words)			Size	No of Pages	Size	No of Pages
ATxmega16A4	16K + 4K	128	Z[6:0]	Z[13:7]	16K	64	4K	16
ATxmega32A4	32K + 4K	128	Z[6:0]	Z[14:7]	32K	128	4K	16
ATxmega64A4	64K + 4K	128	Z[6:0]	Z[15:7]	64K	128	4K	16
ATxmega128A4	128K + 4K	256	Z[7:0]	Z[16:8]	128K	256	4K	16

Table 7-3 on page 12 shows EEPROM memory organization for the XMEGA A4 devices. EEPROM write and erase operations can be performed one page or one byte at the time, while reading the EEPROM is done one byte at the time. For EEPROM access the NVM Address Register (ADDR[m:n]) is used for addressing. The most significant bits in the address (E2PAGE) gives the page number and the least significant address bits (E2BYTE) gives the byte in the page.

Table 7-3. Number of Bytes and Pages in the EEPROM.

Devices	EEPROM Size (Bytes)	Page Size (Bytes)	E2BYTE	E2PAGE	No of Pages
ATxmega16A4	1K	32	ADDR[4:0]	ADDR[10:5]	32
ATxmega32A4	2K	32	ADDR[4:0]	ADDR[10:5]	64
ATxmega64A4	2K	32	ADDR[4:0]	ADDR[10:5]	64
ATxmega128A4	2K	32	ADDR[4:0]	ADDR[10:5]	64

8. DMAC - Direct Memory Access Controller

8.1 Features

- **Allows High-speed data transfer**
  - **From memory to peripheral**
  - **From memory to memory**
  - **From peripheral to memory**
  - **From peripheral to peripheral**
- **4 Channels**
- **From 1 byte and up to 16 M bytes transfers in a single transaction**
- **Multiple addressing modes for source and destination address**
  - **Increment**
  - **Decrement**
  - **Static**
- **1, 2, 4, or 8 bytes Burst Transfers**
- **Programmable priority between channels**

8.2 Overview

The XMEGA A4 has a Direct Memory Access (DMA) Controller to move data between memories and peripherals in the data space. The DMA controller uses the same data bus as the CPU to transfer data.

It has 4 channels that can be configured independently. Each DMA channel can perform data transfers in blocks of configurable size from 1 to 64K bytes. A repeat counter can be used to repeat each block transfer for single transactions up to 16M bytes. Each DMA channel can be configured to access the source and destination memory address with incrementing, decrementing or static addressing. The addressing is independent for source and destination address. When the transaction is complete the original source and destination address can automatically be reloaded to be ready for the next transaction.

The DMAC can access all the peripherals through their I/O memory registers, and the DMA may be used for automatic transfer of data to/from communication modules, as well as automatic data retrieval from ADC conversions, data transfer to DAC conversions, or data transfer to or from port pins. A wide range of transfer triggers is available from the peripherals, Event System and software. Each DMA channel has different transfer triggers.

To allow for continuous transfer, two channels can be interlinked so that the second takes over the transfer when the first is finished and vice versa.

The DMA controller can read from memory mapped EEPROM, but it cannot write to the EEPROM or access the Flash.

9. Event System

9.1 Features

- Inter-peripheral communication and signalling with minimum latency
- CPU and DMA independent operation
- 8 Event Channels allow for up to 8 signals to be routed at the same time
- Events can be generated by
  - TImer/Counters (TCxn)
  - Real Time Counter (RTC)
  - Analog to Digital Converters (ADCx)
  - Analog Comparators (ACx)
  - Ports (PORTx)
  - System Clock (Clk_{SYS})
  - Software (CPU)
- Events can be used by
  - TImer/Counters (TCxn)
  - Analog to Digital Converters (ADCx)
  - Digital to Analog Converters (DACx)
  - Ports (PORTx)
  - DMA Controller (DMAC)
  - IR Communication Module (IRCOM)
- The same event can be used by multiple peripherals for synchronized timing
- Advanced Features
  - Manual Event Generation from software (CPU)
  - Quadrature Decoding
  - Digital Filtering
- Functions in Active and Idle mode

9.2 Overview

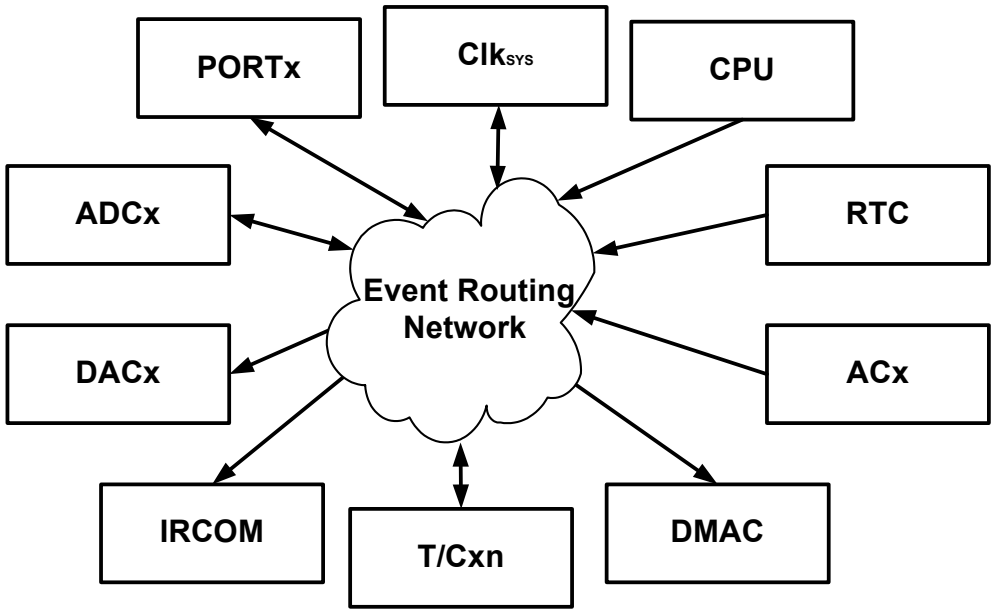
The Event System is a set of features for inter-peripheral communication. It enables the possibility for a change of state in one peripheral to automatically trigger actions in one or more peripherals. What changes in a peripheral that will trigger actions in other peripherals are configurable by software. It is a simple, but powerful system as it allows for autonomous control of peripherals without any use of interrupts, CPU or DMA resources.

The indication of a change in a peripheral is referred to as an event, and is usually the same as the interrupt conditions for that peripheral. Events are passed between peripherals using a dedicated routing network called the Event Routing Network. Figure 9-1 on page 15 shows a basic block diagram of the Event System with the Event Routing Network and the peripherals to which it is connected. This highly flexible system can be used for simple routing of signals, pin functions or for sequencing of events.

The maximum latency is two CPU clock cycles from when an event is generated in one peripheral, until the actions are triggered in one or more other peripherals.

The Event System is functional in both Active and Idle modes.

Figure 9-1. Event System Block Diagram



The Event Routing Network can directly connect together ADCs, DACs, Analog Comparators (ACx), I/O ports (PORTx), the Real-time Counter (RTC), Timer/Counters (T/C) and the IR Communication Module (IRCOM). Events can also be generated from software (CPU).

All events from all peripherals are always routed into the Event Routing Network. This consist of eight multiplexers where each can be configured in software to select which event to be routed into that event channel. All eight event channels are connected to the peripherals that can use events, and each of these peripherals can be configured to use events from one or more event channels to automatically trigger a software selectable action.

10. System Clock and Clock options

10.1 Features

- **Fast start-up time**
- **Safe run-time clock switching**
- **Internal Oscillators:**
  - **32 MHz run-time calibrated RC oscillator**
  - **2 MHz run-time calibrated RC oscillator**
  - **32 kHz calibrated RC oscillator**
  - **32 kHz Ultra Low Power (ULP) oscillator**
- **External clock options**
  - **0.4 - 16 MHz Crystal Oscillator**
  - **32 kHz Crystal Oscillator**
  - **External clock**
- **PLL with internal and external clock options with 2 to 31x multiplication**
- **Clock Prescalers with 2 to 2048x division**
- **Fast peripheral clock running at 2 and 4 times the CPU clock speed**
- **Automatic Run-Time Calibration of internal oscillators**
- **Crystal Oscillator failure detection**

10.2 Overview

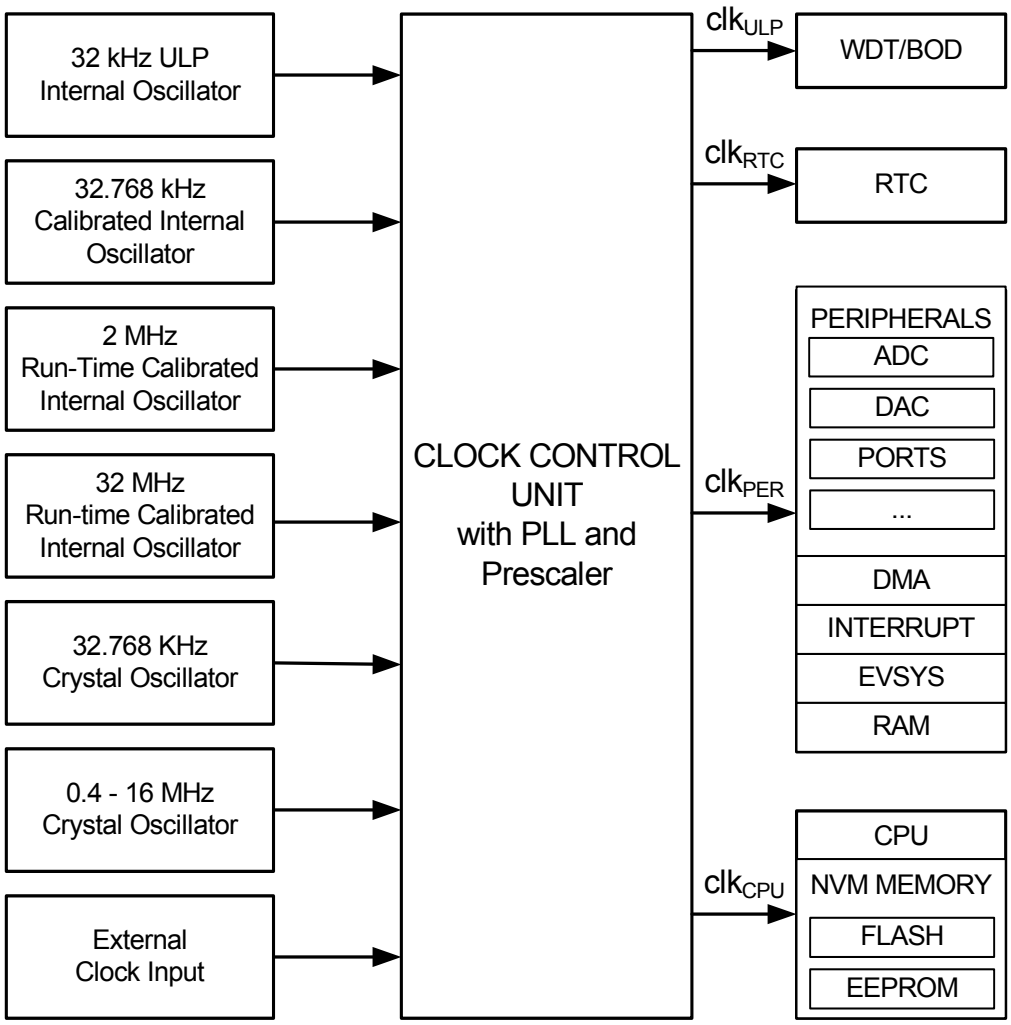
XMEGA A4 has an advanced clock system, supporting a large number of clock sources. It incorporates both integrated oscillators, external crystal oscillators and resonators. A high frequency Phase Locked Loop (PLL) and clock prescalers can be controlled from software to generate a wide range of clock frequencies from the clock source input.

It is possible to switch between clock sources from software during run-time. After reset the device will always start up running from the 2 Mhz internal oscillator.

A calibration feature is available, and can be used for automatic run-time calibration of the internal 2 MHz and 32 MHz oscillators. This reduce frequency drift over voltage and temperature.

A Crystal Oscillator Failure Monitor can be enabled to issue a Non-Maskable Interrupt and switch to internal oscillator if the external oscillator fails. Figure 10-1 on page 17 shows the principal clock system in XMEGA A4.

Figure 10-1. Clock system overview



Each clock source is briefly described in the following sub-sections.

10.3 Clock Options

10.3.1 32 kHz Ultra Low Power Internal Oscillator

The 32 kHz Ultra Low Power (ULP) Internal Oscillator is a very low power consumption clock source. It is used for the Watchdog Timer, Brown-Out Detection and as an asynchronous clock source for the Real Time Counter. This oscillator cannot be used as the system clock source, and it cannot be directly controlled from software.

10.3.2 32.768 kHz Calibrated Internal Oscillator

The 32.768 kHz Calibrated Internal Oscillator is a high accuracy clock source that can be used as the system clock source or as an asynchronous clock source for the Real Time Counter. It is calibrated during protection to provide a default frequency which is close to its nominal frequency.

10.3.3 32.768 kHz Crystal Oscillator

The 32.768 kHz Crystal Oscillator is a low power driver for an external watch crystal. It can be used as system clock source or as asynchronous clock source for the Real Time Counter.

10.3.4 0.4 - 16 MHz Crystal Oscillator

The 0.4 - 16 MHz Crystal Oscillator is a driver intended for driving both external resonators and crystals ranging from 400 kHz to 16 MHz.

10.3.5 2 MHz Run-time Calibrated Internal Oscillator

The 2 MHz Run-time Calibrated Internal Oscillator is a high frequency oscillator. It is calibrated during protection to provide a default frequency which is close to its nominal frequency. The oscillator can use the 32 kHz Calibrated Internal Oscillator or the 32 kHz Crystal Oscillator as a source for calibrating the frequency run-time to compensate for temperature and voltage drift hereby optimizing the accuracy of the oscillator.

10.3.6 32 MHz Run-time Calibrated Internal Oscillator

The 32 MHz Run-time Calibrated Internal Oscillator is a high frequency oscillator. It is calibrated during protection to provide a default frequency which is close to its nominal frequency. The oscillator can use the 32 kHz Calibrated Internal Oscillator or the 32 kHz Crystal Oscillator as a source for calibrating the frequency run-time to compensate for temperature and voltage drift hereby optimizing the accuracy of the oscillator.

10.3.7 External Clock input

The external clock input gives the possibility to connect a clock from an external source.

10.3.8 PLL with Multiplication factor 2 - 31x

The PLL provides the possibility of multiplying a frequency by any number from 2 to 31. In combination with the prescalers, this gives a wide range of output frequencies from all clock sources.

11. Power Management and Sleep Modes

11.1 Features

- 5 sleep modes
  - Idle
  - Power-down
  - Power-save
  - Standby
  - Extended standby
- Power Reduction registers to disable clocks to unused peripherals

11.2 Overview

The XMEGA A4 provides various sleep modes tailored to reduce power consumption to a minimum. All sleep modes are available and can be entered from Active mode. In Active mode the CPU is executing application code. The application code decides when and what sleep mode to enter. Interrupts from enabled peripherals and all enabled reset sources can restore the microcontroller from sleep to Active mode.

In addition, Power Reduction registers provide a method to stop the clock to individual peripherals from software. When this is done, the current state of the peripheral is frozen and there is no power consumption from that peripheral. This reduces the power consumption in Active mode and Idle sleep mode.

11.3 Sleep Modes

11.3.1 Idle Mode

In Idle mode the CPU and Non-Volatile Memory are stopped, but all peripherals including the Interrupt Controller, Event System and DMA Controller are kept running. Interrupt requests from all enabled interrupts will wake the device.

11.3.2 Power-down Mode

In Power-down mode all system clock sources, and the asynchronous Real Time Counter (RTC) clock source, are stopped. This allows operation of asynchronous modules only. The only interrupts that can wake up the MCU are the Two Wire Interface address match interrupts, and asynchronous port interrupts, e.g pin change.

11.3.3 Power-save Mode

Power-save mode is identical to Power-down, with one exception: If the RTC is enabled, it will keep running during sleep and the device can also wake up from RTC interrupts.

11.3.4 Standby Mode

Standby mode is identical to Power-down with the exception that all enabled system clock sources are kept running, while the CPU, Peripheral and RTC clocks are stopped. This reduces the wake-up time when external crystals or resonators are used.

11.3.5 Extended Standby Mode

Extended Standby mode is identical to Power-save mode with the exception that all enabled system clock sources are kept running while the CPU and Peripheral clocks are stopped. This reduces the wake-up time when external crystals or resonators are used.

12. System Control and Reset

12.1 Features

- **Multiple reset sources for safe operation and device reset**
  - **Power-On Reset**
  - **External Reset**
  - **Watchdog Reset**
    - **The Watchdog Timer runs from separate, dedicated oscillator**
  - **Brown-Out Reset**
    - **Accurate, programmable Brown-Out levels**
  - **PDI reset**
  - **Software reset**
- **Asynchronous reset**
  - **No running clock in the device is required for reset**
- **Reset status register**

12.2 Resetting the AVR

During reset, all I/O registers are set to their initial values. The SRAM content is not reset. Application execution starts from the Reset Vector. The instruction placed at the Reset Vector should be an Absolute Jump (JMP) instruction to the reset handling routine. By default the Reset Vector address is the lowest Flash program memory address, ‘0’, but it is possible to move the Reset Vector to the first address in the Boot Section.

The I/O ports of the AVR are immediately tri-stated when a reset source goes active.

The reset functionality is asynchronous, so no running clock is required to reset the device.

After the device is reset, the reset source can be determined by the application by reading the Reset Status Register.

12.3 Reset Sources

12.3.1 Power-On Reset

The MCU is reset when the supply voltage VCC is below the Power-on Reset threshold voltage.

12.3.2 External Reset

The MCU is reset when a low level is present on the RESET pin.

12.3.3 Watchdog Reset

The MCU is reset when the Watchdog Timer period expires and the Watchdog Reset is enabled. The Watchdog Timer runs from a dedicated oscillator independent of the System Clock. For more details see ”WDT - Watchdog Timer” on page 22.

12.3.4 Brown-Out Reset

The MCU is reset when the supply voltage VCC is below the Brown-Out Reset threshold voltage and the Brown-out Detector is enabled. The Brown-out threshold voltage is programmable.

12.3.5 PDI reset

The MCU can be reset through the Program and Debug Interface (PDI).

12.3.6 Software reset

The MCU can be reset by the CPU writing to a special I/O register through a timed sequence.

12.4 WDT - Watchdog Timer

12.4.1 Features

- **11 selectable timeout periods, from 8 ms to 8s.**
- **Two operation modes**
  - **Standard mode**
  - **Window mode**
- **Runs from the 1 kHz output of the 32 kHz Ultra Low Power oscillator**
- **Configuration lock to prevent unwanted changes**

12.4.2 Overview

The XMEGA A4 has a Watchdog Timer (WDT). The WDT will run continuously when turned on and if the Watchdog Timer is not reset within a software configurable time-out period, the microcontroller will be reset. The Watchdog Reset (WDR) instruction must be run by software to reset the WDT, and prevent microcontroller reset.

The WDT has a Window mode. In this mode the WDR instruction must be run within a specified period called a window. Application software can set the minimum and maximum limits for this window. If the WDR instruction is not executed inside the window limits, the microcontroller will be reset.

A protection mechanism using a timed write sequence is implemented in order to prevent unwanted enabling, disabling or change of WDT settings.

For maximum safety, the WDT also has an Always-on mode. This mode is enabled by programming a fuse. In Always-on mode, application software can not disable the WDT.

13. PMIC - Programmable Multi-level Interrupt Controller

13.1 Features

- **Separate interrupt vector for each interrupt**
- **Short, predictable interrupt response time**
- **Programmable Multi-level Interrupt Controller**
  - **3 programmable interrupt levels**
  - **Selectable priority scheme within low level interrupts (round-robin or fixed)**
  - **Non-Maskable Interrupts (NMI)**
- **Interrupt vectors can be moved to the start of the Boot Section**

13.2 Overview

XMEGA A4 has a Programmable Multi-level Interrupt Controller (PMIC). All peripherals can define three different priority levels for interrupts; high, medium or low. Medium level interrupts may interrupt low level interrupt service routines. High level interrupts may interrupt both low- and medium level interrupt service routines. Low level interrupts have an optional round robin scheme to make sure all interrupts are serviced within a certain amount of time.

The built in oscillator failure detection mechanism can issue a Non-Maskable Interrupt (NMI).

13.3 Interrupt vectors

When an interrupt is serviced, the program counter will jump to the interrupt vector address. The interrupt vector is the sum of the peripheral's base interrupt address and the offset address for specific interrupts in each peripheral. The base addresses for the XMEGA A4 devices are shown in Table 13-1. Offset addresses for each interrupt available in the peripheral are described for each peripheral in the XMEGA A manual. For peripherals or modules that have only one interrupt, the interrupt vector is shown in Table 13-1. The program address is the word address.

Table 13-1. Reset and Interrupt Vectors

Program Address (Base Address)	Source	Interrupt Description
0x000	RESET	
0x002	OSCF_INT_vect	Crystal Oscillator Failure Interrupt vector (NMI)
0x004	PORTC_INT_base	Port C Interrupt base
0x008	PORTR_INT_base	Port R Interrupt base
0x00C	DMA_INT_base	DMA Controller Interrupt base
0x014	RTC_INT_base	Real Time Counter Interrupt base
0x018	TWIC_INT_base	Two-Wire Interface on Port C Interrupt base
0x01C	TCC0_INT_base	Timer/Counter 0 on port C Interrupt base
0x028	TCC1_INT_base	Timer/Counter 1 on port C Interrupt base
0x030	SPIC_INT_vect	SPI on port C Interrupt vector
0x032	USARTC0_INT_base	USART 0 on port C Interrupt base
0x038	USARTC1_INT_base	USART 1 on port C Interrupt base
0x03E	AES_INT_vect	AES Interrupt vector

Table 13-1. Reset and Interrupt Vectors (Continued)

Program Address (Base Address)	Source	Interrupt Description
0x040	NVM_INT_base	Non-Volatile Memory Interrupt base
0x044	PORTB_INT_base	Port B Interrupt base
0x056	PORTE_INT_base	Port E Interrupt base
0x05A	TWIE_INT_base	Two-Wire Interface on Port E Interrupt base
0x05E	TCE0_INT_base	Timer/Counter 0 on port E Interrupt base
0x06A	TCE1_INT_base	Timer/Counter 1 on port E Interrupt base
0x074	USARTE0_INT_base	USART 0 on port E Interrupt base
0x080	PORTD_INT_base	Port D Interrupt base
0x084	PORTA_INT_base	Port A Interrupt base
0x088	ACA_INT_base	Analog Comparator on Port A Interrupt base
0x08E	ADCA_INT_base	Analog to Digital Converter on Port A Interrupt base
0x09A	TCD0_INT_base	Timer/Counter 0 on port D Interrupt base
0x0A6	TCD1_INT_base	Timer/Counter 1 on port D Interrupt base
0x0AE	SPID_INT_vector	SPI on port D Interrupt vector
0x0B0	USARTD0_INT_base	USART 0 on port D Interrupt base
0x0B6	USARTD1_INT_base	USART 1 on port D Interrupt base

14. I/O Ports

14.1 Features

- Selectable input and output configuration for each pin individually
- Flexible pin configuration through dedicated Pin Configuration Register
- Synchronous and/or asynchronous input sensing with port interrupts and events
  - Sense both edges
  - Sense rising edges
  - Sense falling edges
  - Sense low level
- Asynchronous wake-up from all input sensing configurations
- Two port interrupts with flexible pin masking
- Highly configurable output driver and pull settings:
  - Totem-pole
  - Pull-up/-down
  - Wired-AND
  - Wired-OR
  - Bus-keeper
  - Inverted I/O
- Optional Slew rate control
- Configuration of multiple pins in a single operation
- Read-Modify-Write (RMW) support
- Toggle/clear/set registers for Output and Direction registers
- Clock output on port pin
- Event Channel 7 output on port pin
- Mapping of port registers (virtual ports) into bit accessible I/O memory space

14.2 Overview

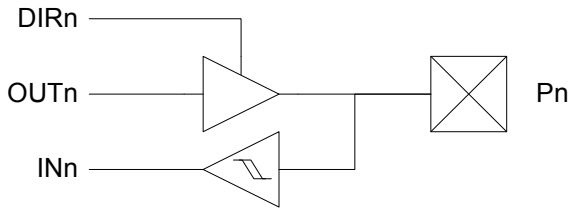
The XMEGA A4 devices have flexible General Purpose I/O Ports. A port consists of up to 8 pins, ranging from pin 0 to pin 7. The ports implement several functions, including synchronous/asynchronous input sensing, pin change interrupts and configurable output settings. All functions are individual per pin, but several pins may be configured in a single operation.

14.3 I/O configuration

All port pins (Pn) have programmable output configuration. In addition, all port pins have an inverted I/O function. For an input, this means inverting the signal between the port pin and the pin register. For an output, this means inverting the output signal between the port register and the port pin. The inverted I/O function can be used also when the pin is used for alternate functions. The port pins also have configurable slew rate limitation to reduce electromagnetic emission.

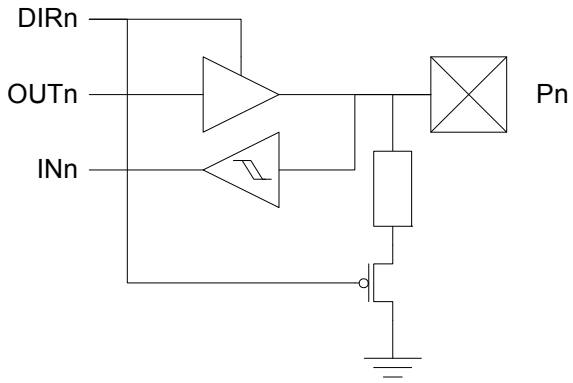
14.3.1 Push-pull

Figure 14-1. I/O configuration - Totem-pole



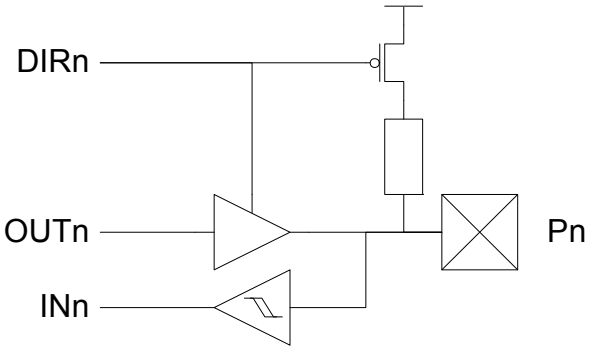
14.3.2 Pull-down

Figure 14-2. I/O configuration - Totem-pole with pull-down (on input)



14.3.3 Pull-up

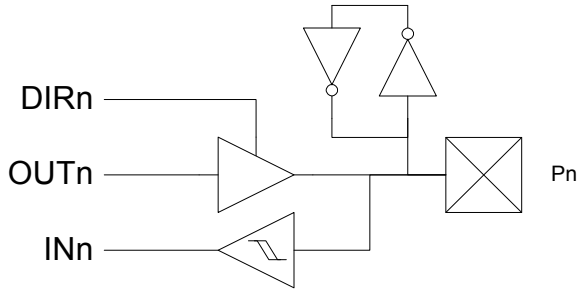
Figure 14-3. I/O configuration - Totem-pole with pull-up (on input)



14.3.4 Bus-keeper

The bus-keeper's weak output produces the same logical level as the last output level. It acts as a pull-up if the last level was '1', and pull-down if the last level was '0'.

Figure 14-4. I/O configuration - Totem-pole with bus-keeper



14.3.5 Others

Figure 14-5. Output configuration - Wired-OR with optional pull-down

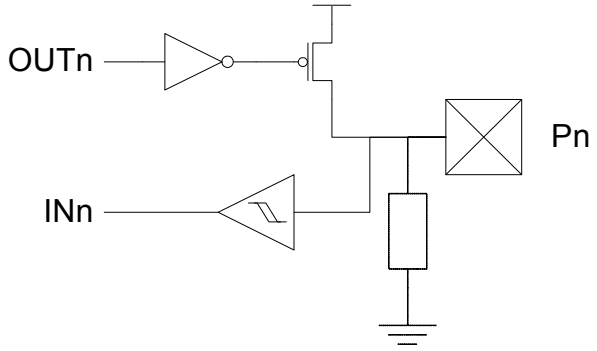
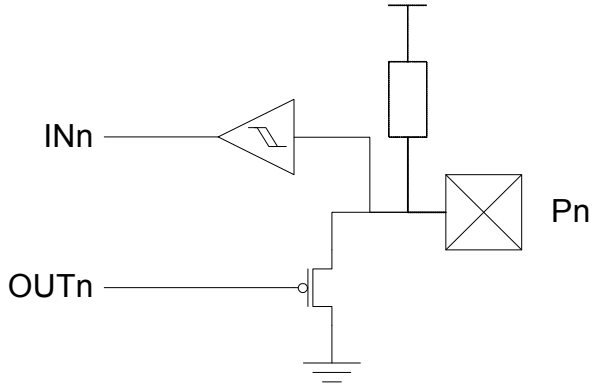


Figure 14-6. I/O configuration - Wired-AND with optional pull-up

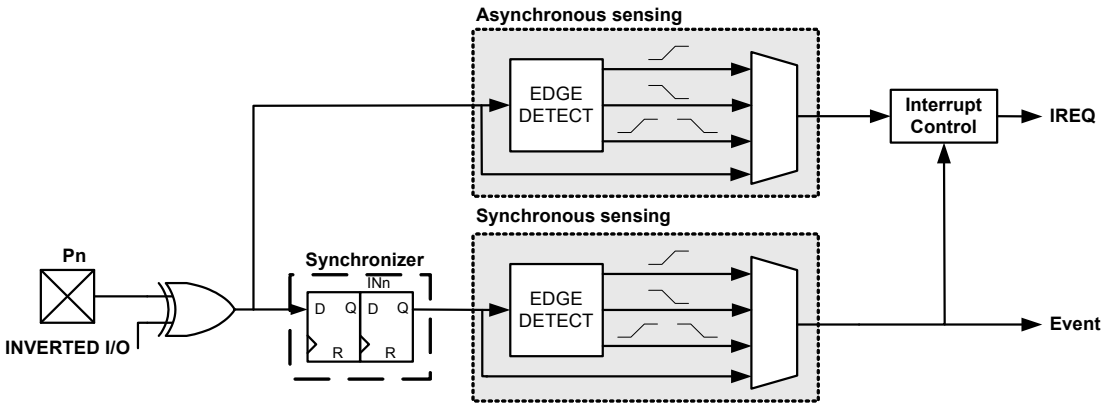


14.4 Input sensing

- **Sense both edges**
- **Sense rising edges**
- **Sense falling edges**
- **Sense low level**

Input sensing is synchronous or asynchronous depending on the enabled clock for the ports, and the configuration is shown in Figure 14-7 on page 28.

Figure 14-7. Input sensing system overview



When a pin is configured with inverted I/O the pin value is inverted before the input sensing.

14.5 Port Interrupt

Each ports have two interrupts with separate priority and interrupt vector. All pins on the port can be individually selected as source for each of the interrupts. The interrupts are then triggered according to the input sense configuration for each pin configured as source for the interrupt.

14.6 Alternate Port Functions

In addition to the input/output functions on all port pins, most pins have alternate functions. This means that other modules or peripherals connected to the port can use the port pins for their functions, such as communication or pulse-width modulation. ”Pinout and Pin Functions” on page 47 shows which modules on peripherals that enable alternate functions on a pin, and which alternate function is available on a pin.

15. T/C - 16-bit Timer/Counter

15.1 Features

- Five 16-bit Timer/Counters
  - Three Timer/Counters of type 0
  - Two Timer/Counters of type 1
- Three Compare or Capture (CC) Channels in Timer/Counter 0
- Two Compare or Capture (CC) Channels in Timer/Counter 1
- Double Buffered Timer Period Setting
- Double Buffered Compare or Capture Channels
- Waveform Generation:
  - Single Slope Pulse Width Modulation
  - Dual Slope Pulse Width Modulation
  - Frequency Generation
- Input Capture:
  - Input Capture with Noise Cancelling
  - Frequency capture
  - Pulse width capture
  - 32-bit input capture
- Event Counter with Direction Control
- Timer Overflow and Timer Error Interrupts and Events
- One Compare Match or Capture Interrupt and Event per CC Channel
- Supports DMA Operation
- Hi-Resolution Extension (Hi-Res)
- Advanced Waveform Extension (AWEX)

15.2 Overview

XMEGA A4 has five Timer/Counters, three Timer/Counter 0 and two Timer/Counter 1. The difference between them is that Timer/Counter 0 has four Compare/Capture channels, while Timer/Counter 1 has two Compare/Capture channels.

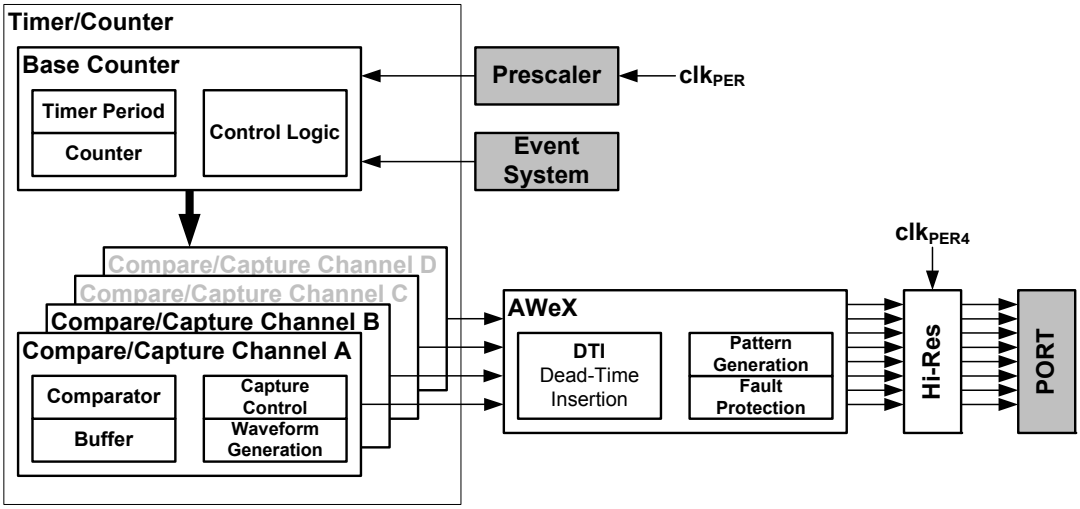
The Timer/Counters (T/C) are 16-bit and can count any clock, event or external input in the microcontroller. A programmable prescaler is available to get a useful T/C resolution. Updates of Timer and Compare registers are double buffered to ensure glitch free operation. Single slope PWM, dual slope PWM and frequency generation waveforms can be generated using the Compare Channels.

Through the Event System, any input pin or event in the microcontroller can be used to trigger input capture, hence no dedicated pins is required for this. The input capture has a noise canceller to avoid incorrect capture of the T/C, and can be used to do frequency and pulse width measurements.

A wide range of interrupt or event sources are available, including T/C Overflow, Compare match and Capture for each Compare/Capture channel in the T/C.

PORTC and PORTD each has one Timer/Counter 0 and one Timer/Counter1. PORTE has one Timer/Conter0. Notation of these are TCC0 (Time/Counter C0), TCC1, TCD0, TCD1 and TCE0, respectively.

Figure 15-1. Overview of a Timer/Counter and closely related peripherals



The Hi-Resolution Extension can be enabled to increase the waveform generation resolution by 2 bits (4x). This is available for all Timer/Counters. See ”Hi-Res - High Resolution Extension” on page 32 for more details.

The Advanced Waveform Extension can be enabled to provide extra and more advanced feature for the Timer/Counter. This is only available for Timer/Counter 0. See ”AWEX - Advanced Waveform Extension” on page 31 for more details.

16. AWEX - Advanced Waveform Extension

16.1 Features

- **Output with complementary output from each Capture channel**
- **Four Dead Time Insertion (DTI) Units, one for each Capture channel**
- **8-bit DTI Resolution**
- **Separate High and Low Side Dead-Time Setting**
- **Double Buffered Dead-Time**
- **Event Controlled Fault Protection**
- **Single Channel Multiple Output Operation (for BLDC motor control)**
- **Double Buffered Pattern Generation**

16.2 Overview

The Advanced Waveform Extension (AWEX) provides extra features to the Timer/Counter in Waveform Generation (WG) modes. The AWEX enables easy and safe implementation of for example, advanced motor control (AC, BLDC, SR, and Stepper) and power control applications.

Any WG output from a Timer/Counter 0 is split into a complimentary pair of outputs when any AWEX feature is enabled. These output pairs go through a Dead-Time Insertion (DTI) unit that enables generation of the non-inverted Low Side (LS) and inverted High Side (HS) of the WG output with dead time insertion between LS and HS switching. The DTI output will override the normal port value according to the port override setting. Optionally the final output can be inverted by using the invert I/O setting for the port pin.

The Pattern Generation unit can be used to generate a synchronized bit pattern on the port it is connected to. In addition, the waveform generator output from Compare Channel A can be distributed to, and override all port pins. When the Pattern Generator unit is enabled, the DTI unit is bypassed.

The Fault Protection unit is connected to the Event System. This enables any event to trigger a fault condition that will disable the AWEX output. Several event channels can be used to trigger fault on several different conditions.

The AWEX is available for TCC0. The notation of this is AWEXC.

17. Hi-Res - High Resolution Extension

17.1 Features

- **Increases Waveform Generator resolution by 2-bits (4x)**
- **Supports Frequency, single- and dual-slope PWM operation**
- **Supports the AWEX when this is enabled and used for the same Timer/Counter**

17.2 Overview

The Hi-Resolution (Hi-Res) Extension is able to increase the resolution of the waveform generation output by a factor of 4. When enabled for a Timer/Counter, the Fast Peripheral clock running at four times the CPU clock speed will be as input to the Timer/Counter.

The High Resolution Extension can also be used when an AWEX is enabled and used with a Timer/Counter.

XMEGA A4 devices have three Hi-Res Extensions that each can be enabled for each Timer/Counters pair on PORTC, PORTD and PORTE. The notation of these are HIRESC, HIRESD and HIRESE, respectively.

18. RTC - 16-bit Real-Time Counter

18.1 Features

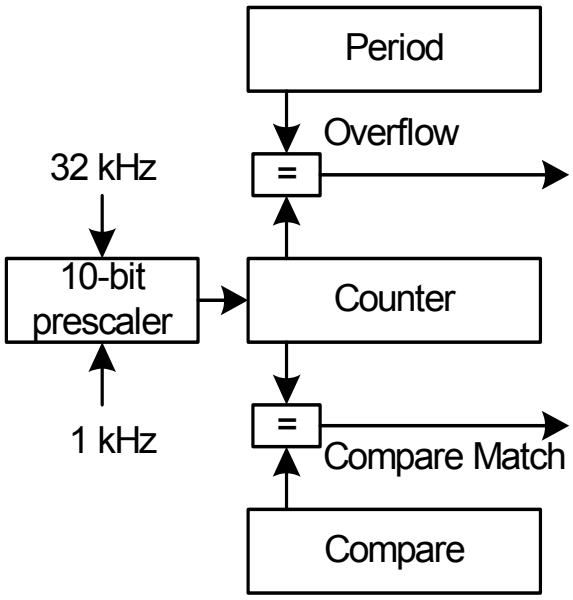
- **16-bit Timer**
- **Flexible Tick resolution ranging from 1 Hz to 32.768 kHz**
- **One Compare register**
- **One Period register**
- **Clear timer on Overflow or Compare Match**
- **Overflow or Compare Match event and interrupt generation**

18.2 Overview

The XMEGA A4 includes a 16-bit Real-time Counter (RTC). The RTC can be clocked from an accurate 32.768 kHz Crystal Oscillator, the 32.768 kHz Calibrated Internal Oscillator, or from the 32 kHz Ultra Low Power Internal Oscillator. The RTC includes both a Period and a Compare register. For details, see Figure 18-1.

A wide range of Resolution and Time-out periods can be configured using the RTC. With a maximum resolution of 30.5 µs, time-out periods range up to 2000 seconds. With a resolution of 1 second, the maximum time-out period is over 18 hours (65536 seconds).

Figure 18-1. Real Time Counter overview



19. TWI - Two-Wire Interface

19.1 Features

- **Two Identical TWI peripherals**
- **Simple yet Powerful and Flexible Communication Interface**
- **Both Master and Slave Operation Supported**
- **Device can Operate as Transmitter or Receiver**
- **7-bit Address Space Allows up to 128 Different Slave Addresses**
- **Multi-master Arbitration Support**
- **Up to 400 kHz Data Transfer Speed**
- **Slew-rate Limited Output Drivers**
- **Noise Suppression Circuitry Rejects Spikes on Bus Lines**
- **Fully Programmable Slave Address with General Call Support**
- **Address Recognition Causes Wake-up when in Sleep Mode**
- **I^2C and System Management Bus (SMBus) compatible**

19.2 Overview

The Two-Wire Interface (TWI) is a bi-directional wired-AND bus with only two lines, the clock (SCL) line and the data (SDA) line. The protocol makes it possible to interconnect up to 128 individually addressable devices. Since it is a multi-master bus, one or more devices capable of taking control of the bus can be connected.

The only external hardware needed to implement the bus is a single pull-up resistor for each of the TWI bus lines. Mechanisms for resolving bus contention are inherent in the TWI protocol.

PORTC and PORTE each has one TWI. Notation of these peripherals are TWIC and TWIE, respectively.

20. SPI - Serial Peripheral Interface

20.1 Features

- **Two Identical SPI peripherals**
- **Full-duplex, Three-wire Synchronous Data Transfer**
- **Master or Slave Operation**
- **LSB First or MSB First Data Transfer**
- **Seven Programmable Bit Rates**
- **End of Transmission Interrupt Flag**
- **Write Collision Flag Protection**
- **Wake-up from Idle Mode**
- **Double Speed (CK/2) Master SPI Mode**

20.2 Overview

The Serial Peripheral Interface (SPI) allows high-speed full-duplex, synchronous data transfer between different devices. Devices can communicate using a master-slave scheme, and data is transferred both to and from the devices simultaneously.

PORTC and PORTD each has one SPI. Notation of these peripherals are SPIC and SPID, respectively.

21. USART

21.1 Features

- Five Identical USART peripherals
- Full Duplex Operation (Independent Serial Receive and Transmit Registers)
- Asynchronous or Synchronous Operation
- Master or Slave Clocked Synchronous Operation
- High-resolution Arithmetic Baud Rate Generator
- Supports Serial Frames with 5, 6, 7, 8, or 9 Data Bits and 1 or 2 Stop Bits
- Odd or Even Parity Generation and Parity Check Supported by Hardware
- Data OverRun Detection
- Framing Error Detection
- Noise Filtering Includes False Start Bit Detection and Digital Low Pass Filter
- Three Separate Interrupts on TX Complete, TX Data Register Empty and RX Complete
- Multi-processor Communication Mode
- Double Speed Asynchronous Communication Mode
- Master SPI mode for SPI communication
- IrDA support through the IRCOM module

21.2 Overview

The Universal Synchronous and Asynchronous serial Receiver and Transmitter (USART) is a highly flexible serial communication module. The USART supports full duplex communication, and both asynchronous and clocked synchronous operation. The USART can also be set in Master SPI mode to be used for SPI communication.

Communication is frame based, and the frame format can be customized to support a wide range of standards. The USART is buffered in both direction, enabling continued data transmission without any delay between frames. There are separate interrupt vectors for receive and transmit complete, enabling fully interrupt driven communication. Frame error and buffer overflow are detected in hardware and indicated with separate status flags. Even or odd parity generation and parity check can also be enabled.

One USART can use the IRCOM module to support IrDA 1.4 physical compliant pulse modulation and demodulation for baud rates up to 115.2 kbps.

PORTC and PORTD each has two USARTs. PORTE has one USART. Notation of these peripherals are USARTC0, USARTC1, USARTD0, USARTD1 and USARTE0, respectively.

22. IRCOM - IR Communication Module

22.1 Features

- **Pulse modulation/demodulation for infrared communication**
- **Compatible to IrDA 1.4 physical for baud rates up to 115.2 kbps**
- **Selectable pulse modulation scheme**
  - **3/16 of baud rate period**
  - **Fixed pulse period, 8-bit programmable**
  - **Pulse modulation disabled**
- **Built in filtering**
- **Can be connected to and used by one USART at the time**

22.2 Overview

XMEGA contains an Infrared Communication Module (IRCOM) for IrDA communication with baud rates up to 115.2 kbps. This supports three modulation schemes: 3/16 of baud rate period, fixed programmable pulse time based on the Peripheral Clock speed, or pulse modulation disabled. There is one IRCOM available which can be connected to any USART to enable infrared pulse coding/decoding for that USART.

23. Crypto Engine

23.1 Features

- **Data Encryption Standard (DES) CPU instruction**
- **Advanced Encryption Standard (AES) Crypto module**
- **DES Instruction**
  - **Encryption and Decryption**
  - **Single-cycle DES instruction**
  - **Encryption/Decryption in 16 clock cycles per 8-byte block**
- **AES Crypto Module**
  - **Encryption and Decryption**
  - **Support 128-bit keys**
  - **Support XOR data load mode to the State memory for Cipher Block Chaining**
  - **Encryption/Decryption in 375 clock cycles per 16-byte block**

23.2 Overview

The Advanced Encryption Standard (AES) and Data Encryption Standard (DES) are two commonly used encryption standards. These are supported through an AES peripheral module and a DES CPU instruction. All communication interfaces and the CPU can optionally use AES and DES encrypted communication and data storage.

DES is supported by a DES instruction in the AVR XMEGA CPU. The 8-byte key and 8-byte data blocks must be loaded into the Register file, and then DES must be executed 16 times to encrypt/decrypt the data block.

The AES Crypto Module encrypts and decrypts 128-bit data blocks with the use of a 128-bit key. The key and data must be loaded into the key and state memory in the module before encryption/decryption is started. It takes 375 peripheral clock cycles before the encryption/decryption is done and decrypted/encrypted data can be read out, and an optional interrupt can be generated. The AES Crypto Module also has DMA support with transfer triggers when encryption/decryption is done and optional auto-start of encryption/decryption when the state memory is fully loaded.

24. ADC - 12-bit Analog to Digital Converter

24.1 Features

- One ADC with 12-bit resolution
- 2 Msps sample rate
- Signed and Unsigned conversions
- 4 result registers with individual input channel control
- 12 single ended inputs
- 8x4 differential inputs
- Software selectable gain of 2, 4, 8, 16, 32 or 64
- Selectable accuracy of 8- or 12-bit.
- Internal or External Reference selection
- Event triggered conversion for accurate timing
- DMA transfer of conversion results
- Interrupt/Event on compare result

24.2 Overview

XMEGA A4 devices have one Analog to Digital Converter (ADC), see Figure 24-1 on page 40.

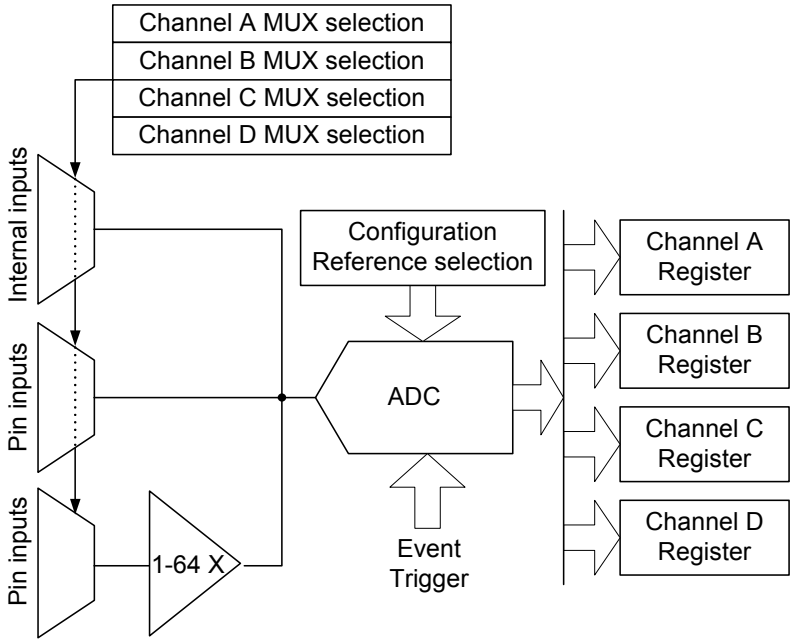
The ADC converts analog voltages to digital values. The ADC has 12-bit resolution and is capable of converting up to 2 million samples per second. The input selection is flexible, and both single-ended and differential measurements can be performed. The ADC can provide both signed and unsigned results, and an optional gain stage is available to increase the dynamic range of the ADC.

It is a Successive Approximation Result (SAR) ADC. A SAR ADC measures one bit of the conversion result at a time. The ADC has a pipeline architecture. This means that a new analog voltage can be sampled and a new ADC measurement started on each ADC clock cycle. Each sample will be converted in the pipeline, where the total sample and conversion time is seven ADC clock cycles for 12-bit result and 5 ADC clock cycles for 8-bit result.

ADC measurements can be started by application software or an incoming event from another peripheral in the device. Four different result registers with individual channel selection (MUX registers) are provided to make it easier for the application to keep track of the data. It is also possible to use DMA to move ADC results directly to memory or peripherals.

Both internal and external analog reference voltages can be used. A very accurate internal 1.0V reference is available.

Figure 24-1. ADC overview



Each ADC has four MUX selection registers with a corresponding result register. This means that four channels can be sampled within 1.5 µs without any intervention by the application other than starting the conversion. The results will be available in the result registers.

The ADC may be configured for 8- or 12-bit resolution, reducing the minimum conversion time (propagation delay) from 3.5 µs for 12-bit to 2.5 µs for 8-bit resolution.

ADC conversion results are provided left- or right adjusted with optional ‘1’ or ‘0’ padding. This eases calculation when the result is represented as a signed integer (signed 16-bit number).

PORTA has one ADC. Notation of this peripheral is ADCA.

25. DAC - 12-bit Digital to Analog Converter

25.1 Features

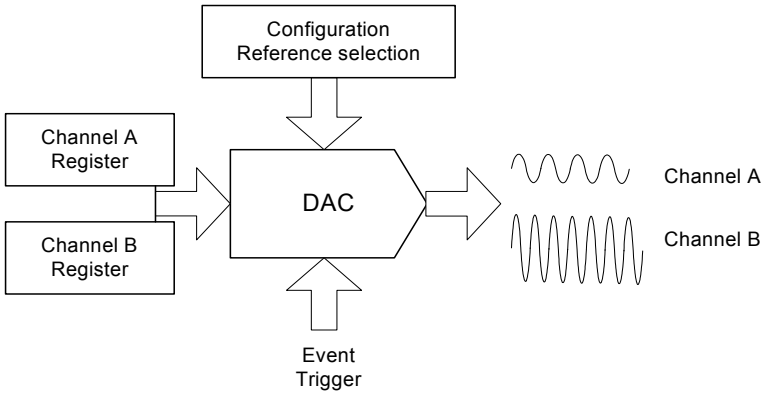
- **One DAC with 12-bit resolution**
- **Up to 1 Msps conversion rate**
- **Flexible conversion range**
- **Multiple trigger sources**
- **1 continuous output or 2 Sample and Hold (S/H) outputs**
- **Built-in offset and gain calibration**
- **High drive capabilities**
- **Low Power Mode**

25.2 Overview

The XMEGA A4 devices feature one 12-bit, 1 Msps DAC with built-in offset and gain calibration, see Figure 25-1 on page 41.

A DAC converts a digital value into an analog signal. The DAC may use an internal 1.1 voltage as the upper limit for conversion, but it is also possible to use the supply voltage or any applied voltage in-between. The external reference input is shared with the ADC reference input.

Figure 25-1. DAC overview



The DAC has one continuous output with high drive capabilities for both resistive and capacitive loads. It is also possible to split the continuous time channel into two Sample and Hold (S/H) channels, each with separate data conversion registers.

A DAC conversion may be started from the application software by writing the data conversion registers. The DAC can also be configured to do conversions triggered by the Event System to have regular timing, independent of the application software. DMA may be used for transferring data from memory locations to DAC data registers.

The DAC has a built-in calibration system to reduce offset and gain error when loading with a calibration value from software.

PORTB has one DAC. Notation of this peripheral is DACB.

26. AC - Analog Comparator

26.1 Features

- **Two Analog Comparators**
- **Selectable Power vs. Speed**
- **Selectable hysteresis**
  - **0, 20 mV, 50 mV**
- **Analog Comparator output available on pin**
- **Flexible Input Selection**
  - **All pins on the port**
  - **Output from the DAC**
  - **Bandgap reference voltage.**
  - **Voltage scaler that can perform a 64-level scaling of the internal VCC voltage.**
- **Interrupt and event generation on**
  - **Rising edge**
  - **Falling edge**
  - **Toggle**
- **Window function interrupt and event generation on**
  - **Signal above window**
  - **Signal inside window**
  - **Signal below window**

26.2 Overview

XMEGA A4 features two Analog Comparators (AC). An Analog Comparator compares two voltages, and the output indicates which input is largest. The Analog Comparator may be configured to give interrupt requests and/or events upon several different combinations of input change.

Both hysteresis and propagation delays may be adjusted in order to find the optimal operation for each application.

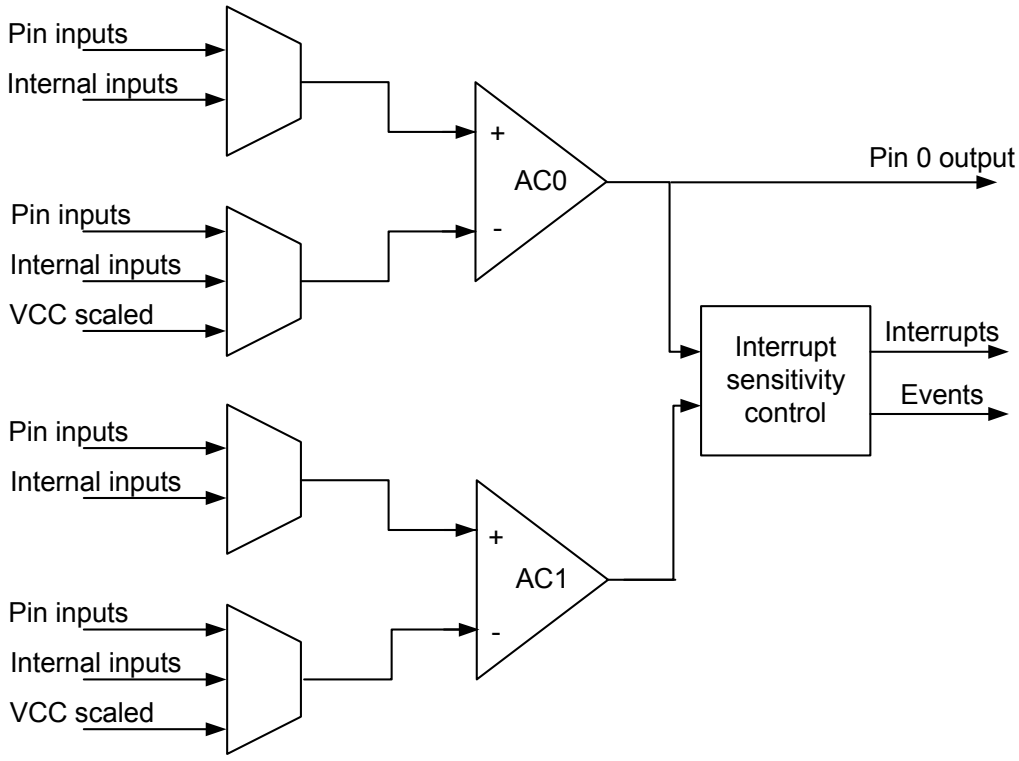
A wide range of input selection is available, both external pins and several internal signals can be used.

The Analog Comparators are always grouped in pairs (AC0 and AC1) on each analog port. They have identical behavior but separate control registers.

Optionally, the state of the comparator is directly available on a pin.

PORTA has one AC pair. Notation of this peripheral is ACA.

Figure 26-1. Analog comparator overview



26.3 Input Selection

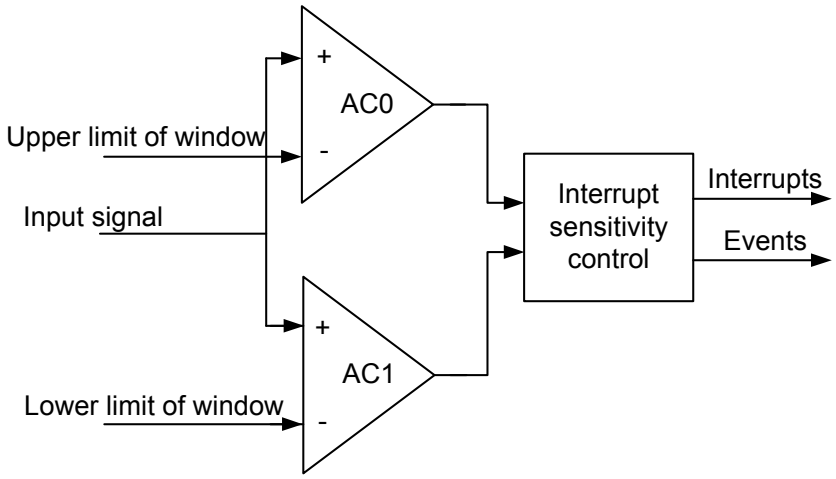
The Analog comparators have a very flexible input selection and the two comparators grouped in a pair may be used to realize a window function. One pair of analog comparators is shown in Figure 26-1 on page 43.

- **Input selection from pin**
  - **Pin 0, 1, 2, 3, 4, 5, 6 selectable to positive input of analog comparator**
  - **Pin 0, 1, 3, 5, 7 selectable to negative input of analog comparator**
- **Internal signals available on positive analog comparator inputs**
  - **Output from 12-bit DAC**
- **Internal signals available on negative analog comparator inputs**
  - **64-level scaler of the VCC, available on negative analog comparator input**
  - **Bandgap voltage reference**
  - **Output from 12-bit DAC**

26.4 Window Function

The window function is realized by connecting the external inputs of the two analog comparators in a pair as shown in Figure 26-2.

Figure 26-2. Analog comparator window function



27. OCD - On-chip Debug

27.1 Features

- Complete Program Flow Control
  - Go, Stop, Reset, Step into, Step over, Step out, Run-to-Cursor
- Debugging on C and high-level language source code level
- Debugging on Assembler and disassembler level
- 1 dedicated program address or source level breakpoint for AVR Studio / debugger
- 4 Hardware Breakpoints
- Unlimited Number of User Program Breakpoints
- Unlimited Number of User Data Breakpoints, with break on:
  - Data location read, write or both read and write
  - Data location content equal or not equal to a value
  - Data location content is greater or less than a value
  - Data location content is within or outside a range
  - Bits of a data location are equal or not equal to a value
- Non-Intrusive Operation
  - No hardware or software resources in the device are used
- High Speed Operation
  - No limitation on debug/programming clock frequency versus system clock frequency

27.2 Overview

The XMEGA A4 has a powerful On-Chip Debug (OCD) system that - in combination with Atmel's development tools - provides all the necessary functions to debug an application. It has support for program and data breakpoints, and can debug an application from C and high level language source code level, as well as assembler and disassembler level. It has full Non-Intrusive Operation and no hardware or software resources in the device are used. The ODC system is accessed through an external debugging tool which connects to the PDI physical interface. Refer to "Program and Debug Interfaces" on page 46.

28. Program and Debug Interfaces

28.1 Features

- **PDI - Program and Debug Interface (Atmel proprietary 2-pin interface)**
- **Access to the OCD system**
- **Programming of Flash, EEPROM, Fuses and Lock Bits**

28.2 Overview

The programming and debug facilities are accessed through PDI physical interface. The PDI physical interface uses one dedicated pin together with the Reset pin, and no general purpose pins are used.

28.3 PDI - Program and Debug Interface

The PDI is an Atmel proprietary protocol for communication between the microcontroller and Atmel's development tools.

29. Pinout and Pin Functions

The pinout of XMEGA A4 is shown in ”Pinout/Block Diagram” on page 2. In addition to general I/O functionality, each pin may have several functions. This will depend on which peripheral is enabled and connected to the actual pin. Only one of the alternate pin functions can be used at time.

29.1 Alternate Pin Functions Description

The tables below shows the notation for all pin functions available and describe their functions.

29.1.1 Operation/Power Supply

VCC	Digital supply voltage
AVCC	Analog supply voltage
GND	Ground

29.1.2 Port Interrupt functions

SYNC	Port pin with full synchronous and limited asynchronous interrupt function
ASYNC	Port pin with full synchronous and full asynchronous interrupt function

29.1.3 Analog functions

ACn	Analog Comparator input pin n
AC0OUT	Analog Comparator 0 Output
ADCn	Analog to Digital Converter input pin n
DACn	Digital to Analog Converter output pin n
AREF	Analog Reference input pin

29.1.4 Timer/Counter and AWEX functions

OCnx	Output Compare Channel x for Timer/Counter n
$\overline{\text{OCnx}}$	Inverted Output Compare Channel x for Timer/Counter n

29.1.5 Communication functions

SCL	Serial Clock for TWI
SDA	Serial Data for TWI
XCKn	Transfer Clock for USART n
RXDn	Receiver Data for USART n
TXDn	Transmitter Data for USART n
$\overline{SS}$	Slave Select for SPI
MOSI	Master Out Slave In for SPI
MISO	Master In Slave Out for SPI
SCK	Serial Clock for SPI

29.1.6 Oscillators, Clock and Event

TOSCn	Timer Oscillator pin n
XTALn	Input/Output for inverting Oscillator pin n

29.1.7 Debug/System functions

$\overline{RESET}$	Reset pin
PDI_CLK	Program and Debug Interface Clock pin
PDI_DATA	Program and Debug Interface Data pin

29.2 Alternate Pin Functions

The tables below shows the main and alternate pin functions for all pins on each port. It also shows which peripheral which make use of or enable the alternate pin function.

Table 29-1. Port A - Alternate functions

PORTA	PIN #	INTERRUPT	ADCA POS	ADCA NEG	ADCA GAINPOS	ADCA GAINNEG	ACA POS	ACA NEG	ACA OUT	REF
GND	38									
AVCC	39									
PA0	40	SYNC	ADC0	ADC0	ADC0		AC0	AC0		AREF
PA1	41	SYNC	ADC1	ADC1	ADC1		AC1	AC1		
PA2	42	SYNC/ASYNC	ADC2	ADC2	ADC2		AC2			
PA3	43	SYNC	ADC3	ADC3	ADC3		AC3	AC3		
PA4	44	SYNC	ADC4		ADC4	ADC4	AC4			
PA5	1	SYNC	ADC5		ADC5	ADC5	AC5	AC5		
PA6	2	SYNC	ADC6		ADC6	ADC6	AC6			
PA7	3	SYNC	ADC7		ADC7	ADC7		AC7	AC0 OUT	

Table 29-2. Port B - Alternate functions

PORTB	PIN #	INTERRUPT	ADCA POS	DACB	REF
PB0	4	SYNC	ADC8		AREF
PB1	5	SYNC	ADC9		
PB2	6	SYNC/ASYNC	ADC10	DAC0	
PB3	7	SYNC	ADC11	DAC1	

Table 29-3. Port C - Alternate functions

PORTC	PIN #	INTERRUPT	TCC0	AWEXC	TCC1	USARTC0	USARTC1	SPI	TWIC	CLOCKOUT	EVENTOUT
GND	8										
VCC	9										
PC0	10	SYNC	OC0A	$\overline{OC0A}$					SDA		
PC1	11	SYNC	OC0B	OC0A		XCK0			SCL		
PC2	12	SYNC/ASYNC	OC0C	$\overline{OC0B}$		RXD0					
PC3	13	SYNC	OC0D	OC0B		TXD0					
PC4	14	SYNC		$\overline{OC0C}$	OC1A			$\overline{SS}$			
PC5	15	SYNC		OC0C	OC1B	XCK0	XCK1	MOSI			
PC6	16	SYNC		$\overline{OC0D}$		RXD0	RXD1	MISO			
PC7	17	SYNC		OC0D		TXD0	TXD1	SCK		CLKOUT	EVOUT

Table 29-4. Port D - Alternate functions

PORTD	PIN #	INTERRUPT	TCD0	USARTD0	USARTD1	SPID	CLOCKOUT	EVENTOUT
GND	18							
VCC	19							
PD0	20	SYNC	OC0A					
PD1	21	SYNC	OC0B	XCK0				
PD2	22	SYNC/ASYNC	OC0C	RXD0				
PD3	23	SYNC	OC0D	TXD0				
PD4	24	SYNC				$\overline{SS}$		
PD5	25	SYNC			XCK1	MOSI		
PD6	26	SYNC			RXD1	MISO		
PD7	27	SYNC			TXD1	SCK	CLKOUT	EVOUT

Table 29-5. Port E - Alternate functions

PORT E	PIN #	INTERRUPT	TCE0	USARTE0	TWIE
PE0	28	SYNC	OC0A		SDA
PE1	29	SYNC	OC0B	XCK0	SCL
GND	30				
VCC	31				
PE2	32	SYNC/ASYNC	OC0C	RXD0	
PE3	33	SYNC	OC0D	TXD0	

Table 29-6. Port R - Alternate functions

PORTR	PIN #	XTAL	PDI
PDI	34		PDI_DATA
$\overline{RESET}$	35		PDI_CLK
PR0	36	XTAL2	
PR1	37	XTAL1	

30. Peripheral Module Address Map

The address maps show the base address for each peripheral and module in XMEGA A4. For complete register description and summary for each peripheral module, refer to the XMEGA A Manual.

Base Address	Name	Description
0x0000	GPIO	General Purpose IO Registers
0x0010	VPORT0	Virtual Port 0
0x0014	VPORT1	Virtual Port 1
0x0018	VPORT2	Virtual Port 2
0x001C	VPORT3	Virtual Port 2
0x0030	CPU	CPU
0x0040	CLK	Clock Control
0x0048	SLEEP	Sleep Controller
0x0050	OSC	Oscillator Control
0x0060	DFLLRC32M	DFLL for the 32 MHz Internal RC Oscillator
0x0068	DFLLRC2M	DFLL for the 2 MHz RC Oscillator
0x0070	PR	Power Reduction
0x0078	RST	Reset Controller
0x0080	WDT	Watch-Dog Timer
0x0090	MCU	MCU Control
0x00A0	PMIC	Programmable MUltilevel Interrupt Controller
0x00B0	PORTCFG	Port Configuration
0x00C0	AES	AES Module
0x0100	DMA	DMA Controller
0x0180	EVSYS	Event System
0x01C0	NVM	Non Volatile Memory (NVM) Controller
0x0200	ADCA	Analog to Digital Converter on port A
0x0320	DACB	Digital to Analog Converter on port B
0x0380	ACA	Analog Comparator pair on port A
0x0400	RTC	Real Time Counter
0x0480	TWIC	Two Wire Interface on port C
0x04A0	TWIE	Two Wire Interface on port E
0x0600	PORTA	Port A
0x0620	PORTB	Port B
0x0640	PORTC	Port C
0x0660	PORTD	Port D
0x0680	PORTE	Port E
0x07E0	PORTR	Port R
0x0800	TCC0	Timer/Counter 0 on port C
0x0840	TCC1	Timer/Counter 1 on port C
0x0880	AWEXC	Advanced Waveform Extension on port C
0x0890	HIRESC	High Resolution Extension on port C
0x08A0	USARTC0	USART 0 on port C
0x08B0	USARTC1	USART 1 on port C
0x08C0	SPIC	Serial Peripheral Interface on port C
0x08F8	IRCOM	Infrared Communication Module
0x0900	TCD0	Timer/Counter 0 on port D
0x0940	TCD1	Timer/Counter 1 on port D
0x0990	HIRESD	High Resolution Extension on port D
0x09A0	USARTD0	USART 0 on port D
0x09B0	USARTD1	USART 1 on port D
0x09C0	SPID	Serial Peripheral Interface on port D
0x0A00	TCE0	Timer/Counter 0 on port E
0x0A90	HIRESE	High Resolution Extension on port E
0x0AA0	USARTE0	USART 0 on port E

31. Interrupt Vector Summary.

31.1 USART Interrupt vectors

Table 31-1. USART Interrupt vectors

Offset	Source	Interrupt Description
0	RXC	USART Receive Complete Interrupt vector offset
2	DRE	USART Data Register Empty Interrupt vector offset
4	TXC	USART Transmit Complete Interrupt vector offset

31.2 Timer/Counter Interrupt vectors

Table 31-2. Timer/Counter Interrupt vectors

Offset	Source	Interrupt Description
0	OVF	Timer/Counter Overflow/Underflow Interrupt vector offset
2	ERR	Timer/Counter Error Interrupt vector offset
4	CCA	Timer/Counter Compare or Capture Channel A Interrupt vector offset
6	CCB	Timer/Counter Compare or Capture Channel B Interrupt vector offset
8	CCC(1)	Timer/Counter Compare or Capture Channel C Interrupt vector offset
0x0A	CCD(1)	Timer/Counter Compare or Capture Channel D Interrupt vector offset

Note: 1. Only available on Timer/Counter with 4 Compare or Capture channels 16-bit.

31.3 SPI Interrupt vectors

Table 31-3. SPI Interrupt vectors

Offset	Source	Interrupt Description
0	SPI	SPI Interrupt vector offset

31.4 TWI Interrupt vectors

Table 31-4. TWI Interrupt vectors

Offset	Source	Interrupt Description
0	MASTER	TWI Master Interrupt vector offset
2	SLAVE	TWI Slave Interrupt vector offset

31.5 DMA Interrupt vectors

Table 31-5. DMA Interrupt vectors

Offset	Source	Interrupt Description
0	CH0	DMA Controller Channel 0 Interrupt vector offset
2	CH1	DMA Controller Channel 1 Interrupt vector offset
4	CH2	DMA Controller Channel 2 Interrupt vector offset
6	CH3	DMA Controller Channel 3 Interrupt vector offset

31.6 Crystal Oscillator Failure Interrupt vector

Table 31-6. Crystal Oscillator Failure Interrupt vector

Offset	Source	Interrupt Description
0	OSCF	Crystal Oscillator Failure Interrupt vector (NMI) offset

31.7 RTC Interrupt vectors

Table 31-7. RTC Interrupt vectors

Offset	Source	Interrupt Description
0	COMP	Real Time Counter Compare Match Interrupt vector offset
2	PER	Real Time Counter Period Interrupt vector offset

31.8 AES Interrupt vector

Table 31-8. AES Interrupt vector

Offset	Source	Interrupt Description
0	AES	AES Interrupt vector offset

31.9 NVM Interrupt vectors

Table 31-9. NVM Interrupt vectors

Offset	Source	Interrupt Description
0	SPM	Non-Volatile Memory SPM Interrupt level vector offset
2	EE	Non-Volatile Memory EEPROM Interrupt level vector offset

31.10 Analog Comparator Interrupt vectors

Table 31-10. Analog Comparator Interrupt vectors

Offset	Source	Interrupt Description
0	COMP0	Analog Comparator 0 Interrupt vector offset
2	COMP1	Analog Comparator 1 Interrupt vector offset
4	WINDOW	Analog Comparator Window Interrupt vector offset

31.11 ADC Interrupt vectors

Table 31-11. Analog to Digital Converter Interrupt vectors

Offset	Source	Interrupt Description
0	CH0	Analog to Digital Converter Channel 0 Interrupt vector offset
2	CH1	Analog to Digital Converter Channel 1 Interrupt vector offset
4	CH2	Analog to Digital Converter Channel 2 Interrupt vector offset
6	CH3	Analog to Digital Converter Channel 3 Interrupt vector offset

31.12 PORTS Interrupt vectors

Table 31-12. Ports Interrupt vectors

Offset	Source	Interrupt Description
0	INT0	Port Interrupt vector 0 offset
2	INT1	Port Interrupt vector 1 offset

32. Instruction Set Summary

Mnemonics	Operands	Description	Operation	Flags	#Clocks
Arithmetic and Logic Instructions					
ADD	Rd, Rr	Add without Carry	Rd ← Rd + Rr	Z,C,N,V,S,H	1
ADC	Rd, Rr	Add with Carry	Rd ← Rd + Rr + C	Z,C,N,V,S,H	1
ADIW	Rd, K	Add Immediate to Word	Rd ← Rd + 1:Rd + K	Z,C,N,V,S	2
SUB	Rd, Rr	Subtract without Carry	Rd ← Rd - Rr	Z,C,N,V,S,H	1
SUBI	Rd, K	Subtract Immediate	Rd ← Rd - K	Z,C,N,V,S,H	1
SBC	Rd, Rr	Subtract with Carry	Rd ← Rd - Rr - C	Z,C,N,V,S,H	1
SBCI	Rd, K	Subtract Immediate with Carry	Rd ← Rd - K - C	Z,C,N,V,S,H	1
SBIW	Rd, K	Subtract Immediate from Word	Rd + 1:Rd ← Rd + 1:Rd - K	Z,C,N,V,S	2
AND	Rd, Rr	Logical AND	Rd ← Rd • Rr	Z,N,V,S	1
ANDI	Rd, K	Logical AND with Immediate	Rd ← Rd • K	Z,N,V,S	1
OR	Rd, Rr	Logical OR	Rd ← Rd v Rr	Z,N,V,S	1
ORI	Rd, K	Logical OR with Immediate	Rd ← Rd v K	Z,N,V,S	1
EOR	Rd, Rr	Exclusive OR	Rd ← Rd ⊕ Rr	Z,N,V,S	1
COM	Rd	One's Complement	Rd ← $FF - Rd	Z,C,N,V,S	1
NEG	Rd	Two's Complement	Rd ← $00 - Rd	Z,C,N,V,S,H	1
SBR	Rd,K	Set Bit(s) in Register	Rd ← Rd v K	Z,N,V,S	1
CBR	Rd,K	Clear Bit(s) in Register	Rd ← Rd • ($FFh - K)	Z,N,V,S	1
INC	Rd	Increment	Rd ← Rd + 1	Z,N,V,S	1
DEC	Rd	Decrement	Rd ← Rd - 1	Z,N,V,S	1
TST	Rd	Test for Zero or Minus	Rd ← Rd • Rd	Z,N,V,S	1
CLR	Rd	Clear Register	Rd ← Rd ⊕ Rd	Z,N,V,S	1
SER	Rd	Set Register	Rd ← $FF	None	1
MUL	Rd,Rr	Multiply Unsigned	R1:R0 ← Rd x Rr (UU)	Z,C	2
MULS	Rd,Rr	Multiply Signed	R1:R0 ← Rd x Rr (SS)	Z,C	2
MULSU	Rd,Rr	Multiply Signed with Unsigned	R1:R0 ← Rd x Rr (SU)	Z,C	2
FMUL	Rd,Rr	Fractional Multiply Unsigned	R1:R0 ← Rd x Rr<<1 (UU)	Z,C	2
FMULS	Rd,Rr	Fractional Multiply Signed	R1:R0 ← Rd x Rr<<1 (SS)	Z,C	2
FMULSU	Rd,Rr	Fractional Multiply Signed with Unsigned	R1:R0 ← Rd x Rr<<1 (SU)	Z,C	2
DES	K	Data Encryption	if (H = 0) then R15:R0 ← Encrypt(R15:R0, K) else if (H = 1) then R15:R0 ← Decrypt(R15:R0, K)		1/2
Branch Instructions					
RJMP	k	Relative Jump	PC ← PC + k + 1	None	2
IJMP		Indirect Jump to (Z)	PC(15:0) ← Z, PC(21:16) ← 0	None	2
EIJMP		Extended Indirect Jump to (Z)	PC(15:0) ← Z, PC(21:16) ← EIND	None	2
JMP	k	Jump	PC ← k	None	3
RCALL	k	Relative Call Subroutine	PC ← PC + k + 1	None	2 / 3[1]
ICALL		Indirect Call to (Z)	PC(15:0) ← Z, PC(21:16) ← 0	None	2 / 3[1]
EICALL		Extended Indirect Call to (Z)	PC(15:0) ← Z, PC(21:16) ← EIND	None	3[1]

Mnemonics	Operands	Description	Operation	Flags	#Clocks
CALL	k	call Subroutine	PC ← k	None	3 / 4[1]
RET		Subroutine Return	PC ← STACK	None	4 / 5[1]
RETI		Interrupt Return	PC ← STACK	I	4 / 5[1]
CPSE	Rd,Rr	Compare, Skip if Equal	if (Rd = Rr) PC ← PC + 2 or 3	None	1 / 2 / 3
CP	Rd,Rr	Compare	Rd - Rr	Z,C,N,V,S,H	1
CPC	Rd,Rr	Compare with Carry	Rd - Rr - C	Z,C,N,V,S,H	1
CPI	Rd,K	Compare with Immediate	Rd - K	Z,C,N,V,S,H	1
SBRC	Rr, b	Skip if Bit in Register Cleared	if (Rr(b) = 0) PC ← PC + 2 or 3	None	1 / 2 / 3
SBRS	Rr, b	Skip if Bit in Register Set	if (Rr(b) = 1) PC ← PC + 2 or 3	None	1 / 2 / 3
SBIC	A, b	Skip if Bit in I/O Register Cleared	if (I/O(A,b) = 0) PC ← PC + 2 or 3	None	2 / 3 / 4
SBIS	A, b	Skip if Bit in I/O Register Set	If (I/O(A,b) =1) PC ← PC + 2 or 3	None	2 / 3 / 4
BRBS	s, k	Branch if Status Flag Set	if (SREG(s) = 1) then PC ← PC + k + 1	None	1 / 2
BRBC	s, k	Branch if Status Flag Cleared	if (SREG(s) = 0) then PC ← PC + k + 1	None	1 / 2
BREQ	k	Branch if Equal	if (Z = 1) then PC ← PC + k + 1	None	1 / 2
BRNE	k	Branch if Not Equal	if (Z = 0) then PC ← PC + k + 1	None	1 / 2
BRCS	k	Branch if Carry Set	if (C = 1) then PC ← PC + k + 1	None	1 / 2
BRCC	k	Branch if Carry Cleared	if (C = 0) then PC ← PC + k + 1	None	1 / 2
BRSH	k	Branch if Same or Higher	if (C = 0) then PC ← PC + k + 1	None	1 / 2
BRLO	k	Branch if Lower	if (C = 1) then PC ← PC + k + 1	None	1 / 2
BRMI	k	Branch if Minus	if (N = 1) then PC ← PC + k + 1	None	1 / 2
BRPL	k	Branch if Plus	if (N = 0) then PC ← PC + k + 1	None	1 / 2
BRGE	k	Branch if Greater or Equal, Signed	if (N ⊕ V= 0) then PC ← PC + k + 1	None	1 / 2
BRLT	k	Branch if Less Than, Signed	if (N ⊕ V= 1) then PC ← PC + k + 1	None	1 / 2
BRHS	k	Branch if Half Carry Flag Set	if (H = 1) then PC ← PC + k + 1	None	1 / 2
BRHC	k	Branch if Half Carry Flag Cleared	if (H = 0) then PC ← PC + k + 1	None	1 / 2
BRTS	k	Branch if T Flag Set	if (T = 1) then PC ← PC + k + 1	None	1 / 2
BRTC	k	Branch if T Flag Cleared	if (T = 0) then PC ← PC + k + 1	None	1 / 2
BRVS	k	Branch if Overflow Flag is Set	if (V = 1) then PC ← PC + k + 1	None	1 / 2
BRVC	k	Branch if Overflow Flag is Cleared	if (V = 0) then PC ← PC + k + 1	None	1 / 2
BRIE	k	Branch if Interrupt Enabled	if (I = 1) then PC ← PC + k + 1	None	1 / 2
BRID	k	Branch if Interrupt Disabled	if (I = 0) then PC ← PC + k + 1	None	1 / 2
Data Transfer Instructions					
MOV	Rd, Rr	Copy Register	Rd ← Rr	None	1
MOVW	Rd, Rr	Copy Register Pair	Rd+1:Rd ← Rr+1:Rr	None	1
LDI	Rd, K	Load Immediate	Rd ← K	None	1
LDS	Rd, k	Load Direct from data space	Rd ← (k)	None	2[1][2]
LD	Rd, X	Load Indirect	Rd ← (X)	None	1[1][2]
LD	Rd, X+	Load Indirect and Post-Increment	Rd ← (X) X ← X + 1	None	1[1][2]
LD	Rd, -X	Load Indirect and Pre-Decrement	X ← X - 1, ← X - 1 Rd ← (X) ← (X)	None	2[1][2]
LD	Rd, Y	Load Indirect	Rd ← (Y) ← (Y)	None	1[1][2]
LD	Rd, Y+	Load Indirect and Post-Increment	Rd ← (Y) Y ← Y + 1	None	1[1][2]

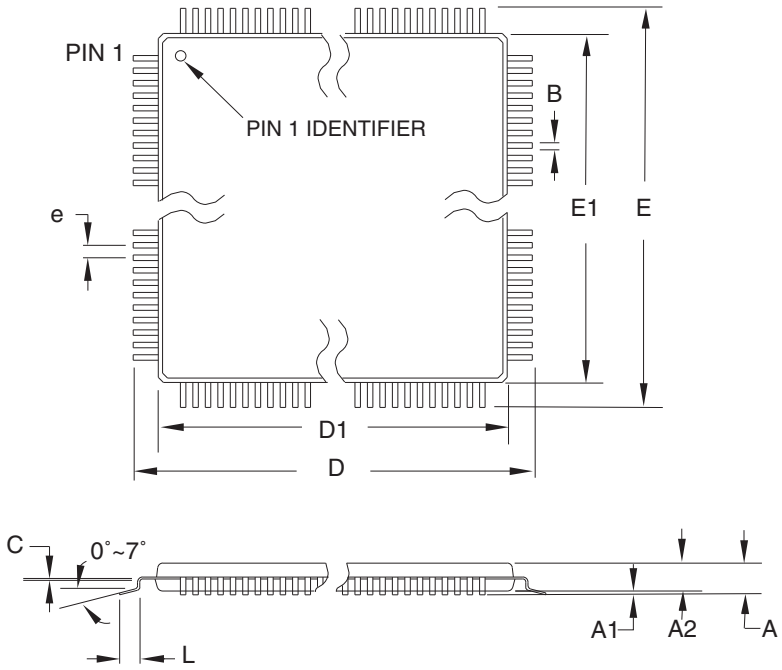
Mnemonics	Operands	Description	Operation	Flags	#Clocks
LD	Rd, -Y	Load Indirect and Pre-Decrement	Y ← Y - 1 Rd ← (Y)	None	2[1][2]
LDD	Rd, Y+q	Load Indirect with Displacement	Rd ← (Y + q)	None	2[1][2]
LD	Rd, Z	Load Indirect	Rd ← (Z)	None	1[1][2]
LD	Rd, Z+	Load Indirect and Post-Increment	Rd ← (Z), Z ← Z+1	None	1[1][2]
LD	Rd, -Z	Load Indirect and Pre-Decrement	Z ← Z - 1, Rd ← (Z)	None	2[1][2]
LDD	Rd, Z+q	Load Indirect with Displacement	Rd ← (Z + q)	None	2[1][2]
STS	k, Rr	Store Direct to Data Space	(k) ← Rd	None	2[1]
ST	X, Rr	Store Indirect	(X) ← Rr	None	1[1]
ST	X+, Rr	Store Indirect and Post-Increment	(X) ← Rr, X ← X + 1	None	1[1]
ST	-X, Rr	Store Indirect and Pre-Decrement	X ← X - 1, (X) ← Rr	None	2[1]
ST	Y, Rr	Store Indirect	(Y) ← Rr	None	1[1]
ST	Y+, Rr	Store Indirect and Post-Increment	(Y) ← Rr, Y ← Y + 1	None	1[1]
ST	-Y, Rr	Store Indirect and Pre-Decrement	Y ← Y - 1, (Y) ← Rr	None	2[1]
STD	Y+q, Rr	Store Indirect with Displacement	(Y + q) ← Rr	None	2[1]
ST	Z, Rr	Store Indirect	(Z) ← Rr	None	1[1]
ST	Z+, Rr	Store Indirect and Post-Increment	(Z) ← Rr Z ← Z + 1	None	1[1]
ST	-Z, Rr	Store Indirect and Pre-Decrement	Z ← Z - 1	None	2[1]
STD	Z+q,Rr	Store Indirect with Displacement	(Z + q) ← Rr	None	2[1]
LPM		Load Program Memory	R0 ← (Z)	None	3
LPM	Rd, Z	Load Program Memory	Rd ← (Z)	None	3
LPM	Rd, Z+	Load Program Memory and Post-Increment	Rd ← (Z), Z ← Z + 1	None	3
ELPM		Extended Load Program Memory	R0 ← (RAMPZ:Z)	None	3
ELPM	Rd, Z	Extended Load Program Memory	Rd ← (RAMPZ:Z)	None	3
ELPM	Rd, Z+	Extended Load Program Memory and Post-Increment	Rd ← (RAMPZ:Z), Z ← Z + 1	None	3
SPM		Store Program Memory	(RAMPZ:Z) ← R1:R0	None	-
SPM	Z+	Store Program Memory and Post-Increment by 2	(RAMPZ:Z) ← R1:R0, Z ← Z + 2	None	-
IN	Rd, A	In From I/O Location	Rd ← I/O(A)	None	1
OUT	A, Rr	Out To I/O Location	I/O(A) ← Rr	None	1
PUSH	Rr	Push Register on Stack	STACK ← Rr	None	1[1]
POP	Rd	Pop Register from Stack	Rd ← STACK	None	2[1]
Bit and Bit-test Instructions					
LSL	Rd	Logical Shift Left	Rd(n+1) ← Rd(n), Rd(0) ← 0, C ← Rd(7)	Z,C,N,V,H	1
LSR	Rd	Logical Shift Right	Rd(n) ← Rd(n+1), Rd(7) ← 0, C ← Rd(0)	Z,C,N,V	1

Mnemonics	Operands	Description	Operation	Flags	#Clocks
ROL	Rd	Rotate Left Through Carry	Rd(0) ← C, Rd(n+1) ← Rd(n), C ← Rd(7)	Z,C,N,V,H	1
ROR	Rd	Rotate Right Through Carry	Rd(7) ← C, Rd(n) ← Rd(n+1), C ← Rd(0)	Z,C,N,V	1
ASR	Rd	Arithmetic Shift Right	Rd(n) ← Rd(n+1), n=0..6	Z,C,N,V	1
SWAP	Rd	Swap Nibbles	Rd(3..0) ↔ Rd(7..4)	None	1
BSET	s	Flag Set	SREG(s) ← 1	SREG(s)	1
BCLR	s	Flag Clear	SREG(s) ← 0	SREG(s)	1
SBI	A, b	Set Bit in I/O Register	I/O(A, b) ← 1	None	1
CBI	A, b	Clear Bit in I/O Register	I/O(A, b) ← 0	None	1
BST	Rr, b	Bit Store from Register to T	T ← Rr(b)	T	1
BLD	Rd, b	Bit load from T to Register	Rd(b) ← T	None	1
SEC		Set Carry	C ← 1	C	1
CLC		Clear Carry	C ← 0	C	1
SEN		Set Negative Flag	N ← 1	N	1
CLN		Clear Negative Flag	N ← 0	N	1
SEZ		Set Zero Flag	Z ← 1	Z	1
CLZ		Clear Zero Flag	Z ← 0	Z	1
SEI		Global Interrupt Enable	I ← 1	I	1
CLI		Global Interrupt Disable	I ← 0	I	1
SES		Set Signed Test Flag	S ← 1	S	1
CLS		Clear Signed Test Flag	S ← 0	S	1
SEV		Set Two's Complement Overflow	V ← 1	V	1
CLV		Clear Two's Complement Overflow	V ← 0	V	1
SET		Set T in SREG	T ← 1	T	1
CLT		Clear T in SREG	T ← 0	T	1
SEH		Set Half Carry Flag in SREG	H ← 1	H	1
CLH		Clear Half Carry Flag in SREG	H ← 0	H	1
MCU Control Instructions					
BREAK		Break	(See specific descr. for BREAK)	None	1
NOP		No Operation		None	1
SLEEP		Sleep	(see specific descr. for Sleep)	None	1
WDR		Watchdog Reset	(see specific descr. for WDR)	None	1

Notes: 1. Cycle times for Data memory accesses assume internal memory accesses, and are not valid for accesses via the external RAM interface.
2. One extra cycle must be added when accessing Internal SRAM.

33. Packaging information

33.1 44A



COMMON DIMENSIONS
(Unit of Measure = mm)

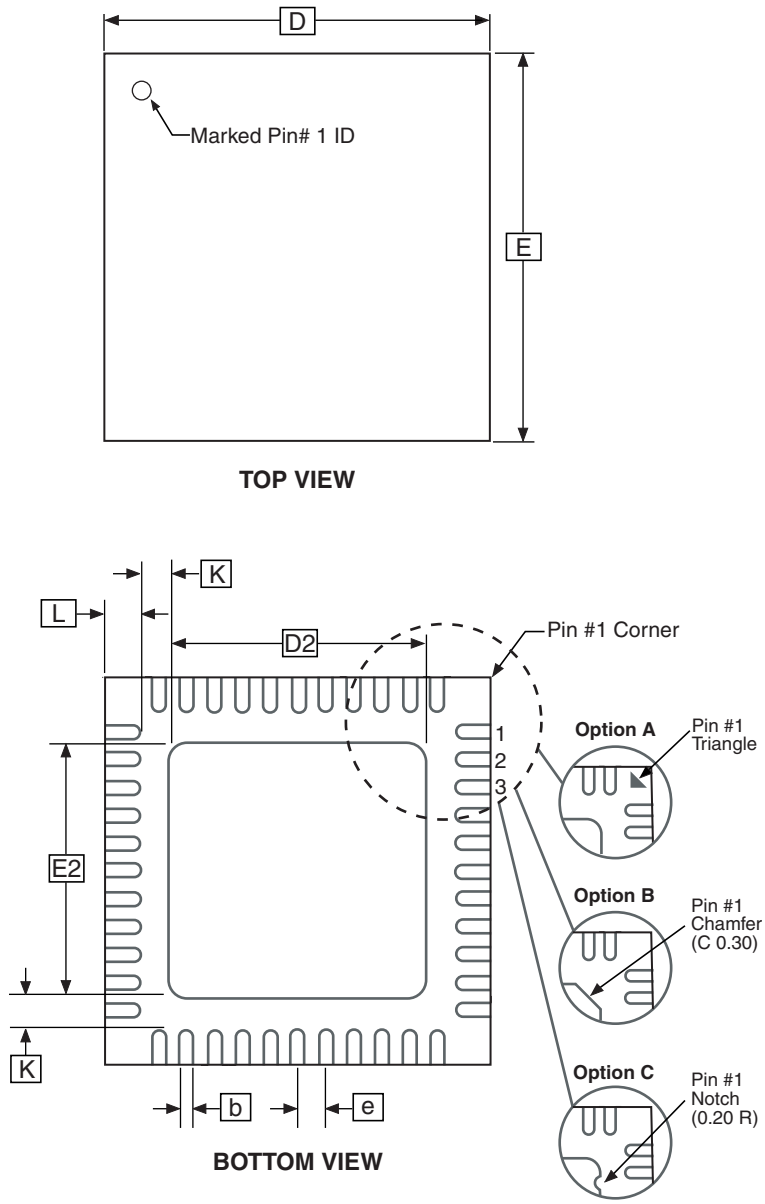
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	
A1	0.05	–	0.15	
A2	0.95	1.00	1.05	
D	11.75	12.00	12.25	
D1	9.90	10.00	10.10	Note 2
E	11.75	12.00	12.25	
E1	9.90	10.00	10.10	Note 2
B	0.30	–	0.45	
C	0.09	–	0.20	
L	0.45	–	0.75	
e	0.80 TYP			

Notes:
1. This package conforms to JEDEC reference MS-026, Variation ACB.
2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
3. Lead coplanarity is 0.10 mm maximum.

10/5/2001

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**44A,** 44-lead, 10 x 10 mm Body Size, 1.0 mm Body Thickness, 0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP)	44A	B

33.2 44M1



Note: JEDEC Standard MO-220, Fig. 1 (SAW Singulation) VKKD-3.

COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	0.80	0.90	1.00	
A1	–	0.02	0.05	
A3		0.25 REF		
b	0.18	0.23	0.30	
D	6.90	7.00	7.10	
D2	5.00	5.20	5.40	
E	6.90	7.00	7.10	
E2	5.00	5.20	5.40	
e		0.50 BSC		
L	0.59	0.64	0.69	
K	0.20	0.26	0.41	

5/27/06

	TITLE	DRAWING NO.	REV.
2325 Orchard Parkway San Jose, CA 95131	**44M1**, 44-pad, 7 x 7 x 1.0 mm Body, Lead Pitch 0.50 mm, 5.20 mm Exposed Pad, Micro Lead Frame Package (MLF)	44M1	G

34. Electrical Characteristics - TBD

34.1 Absolute Maximum Ratings*

Operating Temperature	-55°C to +125°C
Storage Temperature	-65°C to +150°C
Voltage on any Pin with respect to Ground	-0.5V to V_{CC}+0.5V
Maximum Operating Voltage	3.6V
DC Current per I/O Pin	20.0 mA
DC Current V_{CC} and GND Pins	200.0 mA

*NOTICE: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

34.2 DC Characteristics

T_A = -40°C to 85°C, V_{CC} = 1.6V to 3.6V (unless otherwise noted)

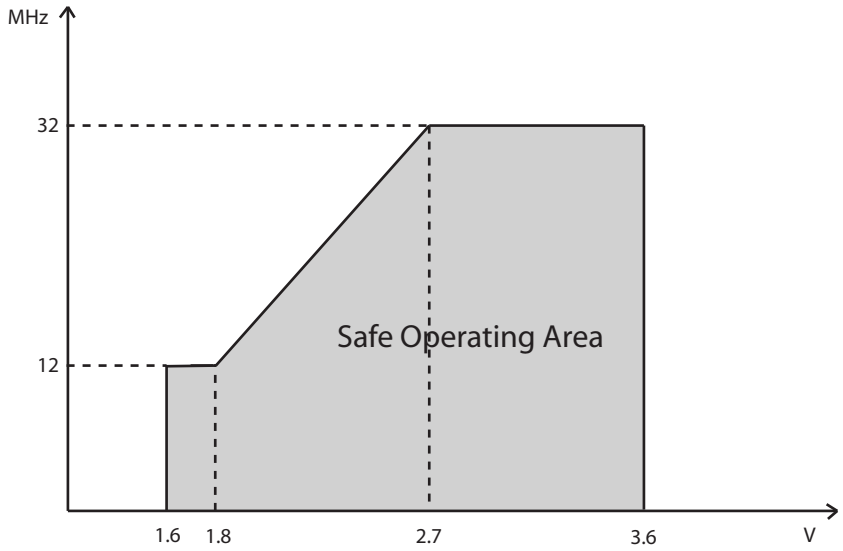
Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V_{IL}	Input Low Voltage, except XTAL1 pin					V
V_{IL1}	Input Low Voltage, XTAL1 pins					V
V_{IH}	Input High Voltage, except XTAL1 pin					V
V_{IH1}	Input High Voltage, XTAL1 pin					V
V_{OL}	Output Low Voltage					
V_{OH}	Output High Voltage					
I_{IL}	Input Leakage Current I/O Pin					µA
I_{IH}	Input Leakage Current I/O Pin					µA
R_{RST}	Reset Pull-up Resistor					kΩ
R_{PU}	I/O Pin Pull-up Resistor					kΩ
I_{CC}	Power Supply Current	Active 32 MHz				mA
		Active 20 MHz				mA
		Active 8MHz				mA
		Idle 32 MHz				mA
		Idle 20 MHz				mA
	Power-down mode	WDT disabled				µA
		WDT slow sampling				µA
		WDT fast sampling				

Note: 1. “Max” means the highest value where the pin is guaranteed to be read as low
2. “Min” means the lowest value where the pin is guaranteed to be read as high

34.3 Speed

The maximum frequency of the XMEGA A4 devices is depending on VCC. As shown in Figure 34-1 on page 62 the Frequency vs.VCC curve is linear between 1.8V < VCC < 2.7V.

Figure 34-1. Maximum Frequency vs.VCC



34.4 ADC Characteristics – TBD

Table 34-1. ADC Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Units
	Resolution					LSB
	Integral Non-Linearity (INL)					LSB
	Differential Non-Linearity (DNL)					LSB
	Gain Error					LSB
	Offset Error					LSB
	Conversion Time					µs
	ADC Clock Frequency					MHz
	DC Supply Voltage					mA
	Source Impedance					Ω
	Start-up time					µs
AVCC	Analog Supply Current		VCC - 0.3		VCC + 0.3	V

Table 34-2. ADC Gain Stage Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Units
	Gain					
	Input Capacitance					pF
	Offset Error					mV
	Gain Error					%
	Signal Range					V
	DC Supply Current					mA
	Start-up time					# clk cycles

34.5 DAC Characteristics – TBD

Table 34-3. DAC Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Units
	Resolution					LSB
	Integral Non-Linearity (INL)					LSB
	Differential Non-Linearity (DNL)					LSB
	Gain Error					LSB
	Offset Error					LSB
	Calibrated Gain/Offset Error					LSB
	Output Range					V
	Output Settling Time					µs
	Output Capacitance					nF
	Output Resistance					kΩ
	Reference Input Voltage					V
	Reference Input Capacitance					pF
	Reference Input Resistance					kΩ
	Current Consumption					mA
	Start-up time					µs

34.6 Analog Comparator Characteristics – TBD

Table 34-4. Analog Comparator Characteristics

Symbol	Parameter	Condition	Min	Typ	Max	Units
	Offset					mV
	Hysteresis	No				mV
		Low				
		High				
	Propagation Delay	High Speed mode				ns
		Low power mode				
	Current Consumption	High Speed mode				µA
		Low power mode				
	Start-up time					µs

35. Typical Characteristics - TBD

36. Errata

36.1 All rev.

No known errata.

37. Datasheet Revision History

37.1 8069D – 08/08

1. Updated ”Features” on page 1 and ”Overview” on page 3.
2. Inserted ”Interrupt Vector Summary.” on page 52.

37.2 8069C – 06/08

1. Updated Figure 2-1 on page 2 and ”Pinout and Pin Functions” on page 47.
2. Updated ”Overview” on page 3.
3. Updated XMEGA A4 Block Diagram, Figure 3-1 on page 4 by removing JTAG from the block diagram.
4. Removed the sections related to JTAG: JTAG Reset and JTAG Interface.
5. Updated Table 13-1 on page 23.
6. Updated all tables in section ”Alternate Pin Functions” on page 49.

37.3 8069B – 06/08

1. Updated ”Features” on page 1.
2. Updated ”Pinout/Block Diagram” on page 2 and ”Pinout and Pin Functions” on page 47.
3. Updated ”Ordering Information” on page 2.
4. Updated ”Overview” on page 3, included the XMEGA A4 explanation text on page 6.
5. Added XMEGA A4 Block Diagram, Figure 3-1 on page 4.
6. Updated AVR CPU ”Features” on page 6 and Updated Figure 6-1 on page 6.
7. Updated Event System block diagram, Figure 9-1 on page 15.
8. Updated ”PMIC - Programmable Multi-level Interrupt Controller” on page 23.
9. Updated ”AC - Analog Comparator” on page 42.
10. Updated ”I/O configuration” on page 25.
11. Inserted a new Figure 15-1 on page 30.
12. Updated ”Peripheral Module Address Map” on page 51.
13. Inserted ”Instruction Set Summary” on page 55.
14. Added Speed grades in ”Speed” on page 62.

37.4 8069A – 02/08

1. Initial revision.

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